

- **High-Performance Floating-Point Digital Signal Processor (DSP)**
 - TMS320C30-50 (5 V)
40-ns Instruction Cycle Time
275 MOPS, 50 MFLOPS, 25 MIPS
 - TMS320C30-40 (5 V)
50-ns Instruction Cycle Time
220 MOPS, 40 MFLOPS, 20 MIPS
 - TMS320C30-33 (5 V)
60-ns Instruction Cycle Time
183.3 MOPS, 33.3 MFLOPS, 16.7 MIPS
 - TMS320C30-27 (5 V)
74-ns Instruction Cycle Time
148.5 MOPS, 27 MFLOPS, 13.5 MIPS
- **32-Bit High-Performance CPU**
- **16-/32-Bit Integer and 32-/40-Bit Floating-Point Operations**
- **32-Bit Instruction Word, 24-Bit Addresses**
- **Two 1K × 32-Bit Single-Cycle Dual-Access On-Chip RAM Blocks**
- **One 4K × 32-Bit Single-Cycle Dual-Access On-Chip ROM Block**
- **On-Chip Memory-Mapped Peripherals:**
 - Two Serial Ports
 - Two 32-Bit Timers
 - One-Channel Direct Memory Access (DMA) Coprocessor for Concurrent I/O and CPU Operation
- **Two 32-Bit External Ports**
- **24- and 13-Bit Addresses**
- **0.7- μ m Enhanced Performance Implanted CMOS (EPIC™) Technology**
- **208-Pin Plastic Quad Flat Package (PPM Suffix)**
- **181-Pin Grid Array Ceramic Package (GEL Suffix)**
- **Eight Extended-Precision Registers**
- **Two Address Generators With Eight Auxiliary Registers and Two Auxiliary Register Arithmetic Units (ARAUs)**
- **Two- and Three-Operand Instructions**
- **Parallel Arithmetic and Logic Unit (ALU) and Multiplier Execution in a Single Cycle**
- **Block-Repeat Capability**
- **Zero-Overhead Loops With Single-Cycle Branches**
- **Conditional Calls and Returns**
- **Interlocked Instructions for Multiprocessing Support**
- **Two Sets of Memory Strobes ($\overline{\text{STRB}}$ and $\overline{\text{MSTRB}}$) and One I/O Strobe ($\overline{\text{IOSTRB}}$)**
- **Separate Bus-Control Registers for Each Strobe-Control Wait-State Generation**

description

The TMS320C30 is the newest member of the TMS320C3x generation of DSPs from Texas Instruments (TI™). The TMS320C30 is a 32-bit floating-point processor manufactured in 0.7- μ m triple-level-metal CMOS technology.

The TMS320C30's internal busing and special DSP instruction set have the speed and flexibility to execute up to 50 MFLOPS (million floating-point operations per second). The TMS320C30 optimizes speed by implementing functions in hardware that other processors implement through software or microcode. This hardware-intensive approach provides performance previously unavailable on a single chip.

The TMS320C30 can perform parallel multiply and ALU operations on integer or floating-point data in a single cycle. Each processor also possesses a general-purpose register file, a program cache, dedicated ARAUs, internal dual-access memories, one DMA channel supporting concurrent I/O, and a short machine-cycle time. High performance and ease of use are results of these features.

General-purpose applications are enhanced greatly by the large address space, multiprocessor interface, internally and externally generated wait states, two external interface ports, two timers, serial ports, and multiple interrupt structure. The TMS320C30 supports a wide variety of system applications from host processor to dedicated coprocessor.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

EPIC and TI are trademarks of Texas Instruments Incorporated.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

Copyright © 1997, Texas Instruments Incorporated

■ 0961722 0099367 882 ■

TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

description (continued)

High-level language support is implemented easily through a register-based architecture, large address space, powerful addressing modes, flexible instruction set, and well-supported floating-point arithmetic.

pinout and pin assignments

TMS320C30 GEL pinout and pin assignments

The TMS320C30 digital signal processor is available in a 181-pin grid array (PGA) package. The pinout of this package is shown in the following two illustrations. The pin assignments are listed in the TMS320C30 GEL pin assignments (alphabetical) table and the TMS320C30 GEL pin assignments (numerical) table.

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	
A	H3 ()	D2 ()	D3 ()	D7 ()	D10 ()	D13 ()	D16 ()	D17 ()	D19 ()	D22 ()	D25 ()	D28 ()	XA0 ()	XA1 ()	XA5 ()	
B	X2/CLKIN ()	CVSS ()	H1 ()	D4 ()	D8 ()	D11 ()	D15 ()	D18 ()	D20 ()	D24 ()	D27 ()	D31 ()	XA4 ()	IVSS ()	XA6 ()	
C	EMU5 ()	X1 ()	DVSS ()	D0 ()	D5 ()	D9 ()	D14 ()	VSS ()	D21 ()	D26 ()	D30 ()	XA3 ()	DVSS ()	XA7 ()	XA10 ()	
D	XRW ()	XRDY ()	VBBP ()	DDVDD ()	D1 ()	D6 ()	D12 ()	VDD ()	D23 ()	D29 ()	XA2 ()	ADVDD ()	XA9 ()	XA11 ()	MC/MP ()	
E	RDY ()	HOLDA ()	MSTRB ()	VSUBS ()	LOCATOR ()			DDVDD ()				XA8 ()	XA12 ()	EMU3 ()	EMU1 ()	
F	RESET ()	STRB ()	HOLD ()	IOSTRB ()								EMU4/SHZ ()	EMU2 ()	EMU0 ()	A0 ()	
G	IACK ()	XF0 ()	XF1 ()	RW ()								A1 ()	A2 ()	A3 ()	A4 ()	
H	INT1 ()	INT0 ()	VSS ()	VDD ()	MDVDD ()							ADVDD ()	VDD ()	VSS ()	A6 ()	A5 ()
J	INT2 ()	INT3 ()	RSV0 ()	RSV1 ()								A11 ()	A9 ()	A8 ()	A7 ()	
K	RSV2 ()	RSV3 ()	RSV5 ()	RSV7 ()								A17 ()	A14 ()	A12 ()	A10 ()	
L	RSV4 ()	RSV6 ()	RSV9 ()	CLKR1 ()								A22 ()	A18 ()	A15 ()	A13 ()	
M	RSV8 ()	RSV10 ()	FSR1 ()	PDVDD ()	CLKX0 ()	EMU6 ()	XD5 ()	VDD ()	XD16 ()	XD22 ()	XD27 ()	IODVDD ()	A21 ()	A19 ()	A16 ()	
N	DR1 ()	CLKX1 ()	DVSS ()	CLKR0 ()	TCLK1 ()	XD2 ()	XD7 ()	VSS ()	XD14 ()	XD19 ()	XD23 ()	XD28 ()	DVSS ()	A23 ()	A20 ()	
P	FSX1 ()	DX1 ()	FSR0 ()	TCLK0 ()	XD1 ()	XD4 ()	XD8 ()	XD10 ()	XD13 ()	XD17 ()	XD20 ()	XD24 ()	XD29 ()	CVSS ()	XD31 ()	
R	DR0 ()	FSX0 ()	DX0 ()	XD0 ()	XD3 ()	XD6 ()	XD9 ()	XD11 ()	XD12 ()	XD15 ()	XD18 ()	XD21 ()	XD25 ()	XD26 ()	XD30 ()	

TMS320C30 GEL Pinout (Top View)



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

8961722 0099368 719

TMS320C30 GEL pinout and pin assignments (continued)

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	
XA5	XA1	XA0	D28	D25	D22	D19	D17	D16	D13	D10	D7	D3	D2	H3	A
●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	B
XA6	IVSS	XA4	D31	D27	D24	D20	D18	D15	D11	D8	D4	H1	CVSS	X2/CLKIN	C
●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	D
XA10	XA7	DVSS	XA3	D30	D26	D21	VSS	D14	D9	D5	D0	DVSS	X1	EMU5	E
●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	F
MC/MP	XA11	XA9	ADVDD	XA2	D29	D23	VDD	D12	D6	D1	DDVDD	VBBP	XRDY	XRW	G
●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	H
EMU1	EMU3	XA12	XA8				DDVDD		LOCATOR	VSUBS	MSTRB	HOLDA	RDY		J
●	●	●	●				●		●	●	●	●	●	●	K
A0	EMU0	EMU2	EMU4/SHZ								IOSTRB	HOLD	STRB	RESET	L
●	●	●	●								●	●	●	●	M
A4	A3	A2	A1								RW	XF1	XF0	IACK	N
●	●	●	●								●	●	●	●	P
A5	A6	VSS	VDD	ADVDD						MDVDD	VDD	VSS	INT0	INT1	R
●	●	●	●	●						●	●	●	●	●	
A7	A8	A9	A11								RSV1	RSV0	INT3	INT2	
●	●	●	●								●	●	●	●	
A10	A12	A14	A17								RSV7	RSV5	RSV3	RSV2	
●	●	●	●								●	●	●	●	
A13	A15	A18	A22				IODVDD				CLKR1	RSV9	RSV6	RSV4	
●	●	●	●				●				●	●	●	●	
A16	A19	A21	IODVDD	XD27	XD22	XD16	VDD	XD5	EMU6	CLKX0	PDVDD	FSR1	RSV10	RSV8	
●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	
A20	A23	DVSS	XD28	XD23	XD19	XD14	VSS	XD7	XD2	TCLK1	CLKR0	DVSS	CLKX1	DR1	
●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	
XD31	CVSS	XD29	XD24	XD20	XD17	XD13	XD10	XD8	XD4	XD1	TCLK0	FSR0	DX1	FSX1	
●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	
XD30	XD26	XD25	XD21	XD18	XD15	XD12	XD11	XD9	XD6	XD3	XD0	DX0	FSX0	DR0	
●	●	●	●	●	●	●	●	●	●	●	●	●	●	●	

TMS320C30 GEL Pinout (Bottom View)



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

8961722 0099369 655

TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

TMS320C30 GEL Pin Assignments (Alphabetical) †

PIN		PIN		PIN		PIN		PIN	
NAME	NO.	NAME	NO.	NAME	NO.	NAME	NO.	NAME	NO.
A0	F15	D8	B5	EMU6	M6	V _{BBP}	D3	XD15	R10
A1	G12	D9	C6	FSR0	P3	V _{DD}	D8	XD16	M9
A2	G13	D10	A5	FSR1	M3	V _{DD}	H4	XD17	P10
A3	G14	D11	B6	FSX0	R2	V _{DD}	H12	XD18	R11
A4	G15	D12	D7	FSX1	P1	V _{DD}	M8	XD19	N10
A5	H15	D13	A6	H1	B3	V _{SS}	C8	XD20	P11
A6	H14	D14	C7	H3	A1	V _{SS}	H3	XD21	R12
A7	J15	D15	B7	HOLD	F3	V _{SS}	H13	XD22	M10
A8	J14	D16	A7	HOLDA	E2	V _{SS}	N8	XD23	N11
A9	J13	D17	A8	IACK	G1	V _{SUBS}	E4	XD24	P12
A10	K15	D18	B8	INT0	H2	X1	C2	XD25	R13
A11	J12	D19	A9	INT1	H1	X2/CLKIN	B1	XD26	R14
A12	K14	D20	B9	INT2	J1	XA0	A13	XD27	M11
A13	L15	D21	C9	INT3	J2	XA1	A14	XD28	N12
A14	K13	D22	A10	IODV _{DD}	L8	XA2	D11	XD29	P13
A15	L14	D23	D9	IODV _{DD}	M12	XA3	C12	XD30	R15
A16	M15	D24	B10	IOSTRB	F4	XA4	B13	XD31	P15
A17	K12	D25	A11	IV _{SS}	B14	XA5	A15	XF0	G2
A18	L13	D26	C10	LOCATOR	E5	XA6	B15	XF1	G3
A19	M14	D27	B11	MC/MP	D15	XA7	C14	XRDY	D2
A20	N15	D28	A12	MDV _{DD}	H5	XA8	E12	XR/W	D1
A21	M13	D29	D10	MSTRB	E3	XA9	D13		
A22	L12	D30	C11	PDV _{DD}	M4	XA10	C15		
A23	N14	D31	B12	RDY	E1	XA11	D14		
ADV _{DD}	D12	DDV _{DD}	D4	RESET	F1	XA12	E13		
ADV _{DD}	H11	DDV _{DD}	E8	RSV0	J3	XD0	R4		
CLKR0	N4	DR0	R1	RSV1	J4	XD1	P5		
CLKR1	L4	DR1	N1	RSV2	K1	XD2	N6		
CLKX0	M5	DV _{SS}	C3	RSV3	K2	XD3	R5		
CLKX1	N2	DV _{SS}	C13	RSV4	L1	XD4	P6		
CV _{SS}	B2	DV _{SS}	N3	RSV5	K3	XD5	M7		
CV _{SS}	P14	DV _{SS}	N13	RSV6	L2	XD6	R6		
D0	C4	DX0	R3	RSV7	K4	XD7	N7		
D1	D5	DX1	P2	RSV8	M1	XD8	P7		
D2	A2	EMU0	F14	RSV9	L3	XD9	R7		
D3	A3	EMU1	E15	RSV10	M2	XD10	P8		
D4	B4	EMU2	F13	R/W	G4	XD11	R8		
D5	C5	EMU3	E14	STRB	F2	XD12	R9		
D6	D6	EMU4/SHZ	F12	TCLK0	P4	XD13	P9		
D7	A4	EMU5	C1	TCLK1	N5	XD14	N9		

† ADV_{DD}, CV_{SS}, DDV_{DD}, DV_{SS}, IODV_{DD}, IV_{SS}, MDV_{DD}, PDV_{DD}, V_{DD}, and V_{SS} pins are on a common plane internal to the device.



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

TMS320C30 GEL Pin Assignments (Numerical)†

PIN		PIN		PIN		PIN		PIN	
NAME	NO.	NAME	NO.	NAME	NO.	NAME	NO.	NAME	NO.
H3	A1	D30	C11	XF1	G3	A13	L15	XD17	P10
D2	A2	XA3	C12	R/W	G4	RSV8	M1	XD20	P11
D3	A3	DVSS	C13	A1	G12	FSV10	M2	XD24	P12
D7	A4	XA7	C14	A2	G13	FSR1	M3	XD29	P13
D10	A5	XA10	C15	A3	G14	PDVDD	M4	CVSS	P14
D13	A6	XR/W	D1	A4	G15	CLKX0	M5	XD31	P15
D16	A7	XRDY	D2	INT1	H1	EMU6	M6	DR0	R1
D17	A8	VBBP	D3	INT0	H2	XD5	M7	FSX0	R2
D19	A9	DDVDD	D4	VSS	H3	VDD	M8	DX0	R3
D22	A10	D1	D5	VDD	H4	XD16	M9	XD0	R4
D25	A11	D6	D6	MDVDD	H5	XD22	M10	XD3	R5
D28	A12	D12	D7	ADVDD	H11	XD27	M11	XD6	R6
XA0	A13	VDD	D8	VDD	H12	IODVDD	M12	XD9	R7
XA1	A14	D23	D9	VSS	H13	A21	M13	XD11	R8
XA5	A15	D29	D10	A6	H14	A19	M14	XD12	R9
X2/CLKIN	B1	XA2	D11	A5	H15	A16	M15	XD15	R10
CVSS	B2	ADVDD	D12	INT2	J1	DR1	N1	XD18	R11
H1	B3	XA9	D13	INT3	J2	CLKX1	N2	XD21	R12
D4	B4	XA11	D14	RSV0	J3	DVSS	N3	XD25	R13
D8	B5	MC/MP	D15	RSV1	J4	CLKR0	N4	XD26	R14
D11	B6	RDY	E1	A11	J12	TCLK1	N5	XD30	R15
D15	B7	HOLDA	E2	A9	J13	XD2	N6		
D18	B8	MSTRB	E3	A8	J14	XD7	N7		
D20	B9	VSUBS	E4	A7	J15	VSS	N8		
D24	B10	LOCATOR	E5	RSV2	K1	XD14	N9		
D27	B11	DDVDD	E8	RSV3	K2	XD19	N10		
D31	B12	XA8	E12	RSV5	K3	XD23	N11		
XA4	B13	XA12	E13	RSV7	K4	XD28	N12		
IVSS	B14	EMU3	E14	A17	K12	DVSS	N13		
XA6	B15	EMU1	E15	A14	K13	A23	N14		
EMU5	C1	RESET	F1	A12	K14	A20	N15		
X1	C2	STRB	F2	A10	K15	FSX1	P1		
DVSS	C3	HOLD	F3	RSV4	L1	DX1	P2		
D0	C4	IOSTRB	F4	RSV6	L2	FSR0	P3		
D5	C5	EMU4/SHZ	F12	RSV9	L3	TCLK0	P4		
D9	C6	EMU2	F13	CLKR1	L4	XD1	P5		
D14	C7	EMU0	F14	IODVDD	L8	XD4	P6		
VSS	C8	A0	F15	A22	L12	XD8	P7		
D21	C9	IACK	G1	A18	L13	XD10	P8		
D26	C10	XF0	G2	A15	L14	XD13	P9		

† ADVDD, CVSS, DDVDD, DVSS, IODVDD, IVSS, MDVDD, PDVDD, VDD, and VSS pins are on a common plane internal to the device.



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

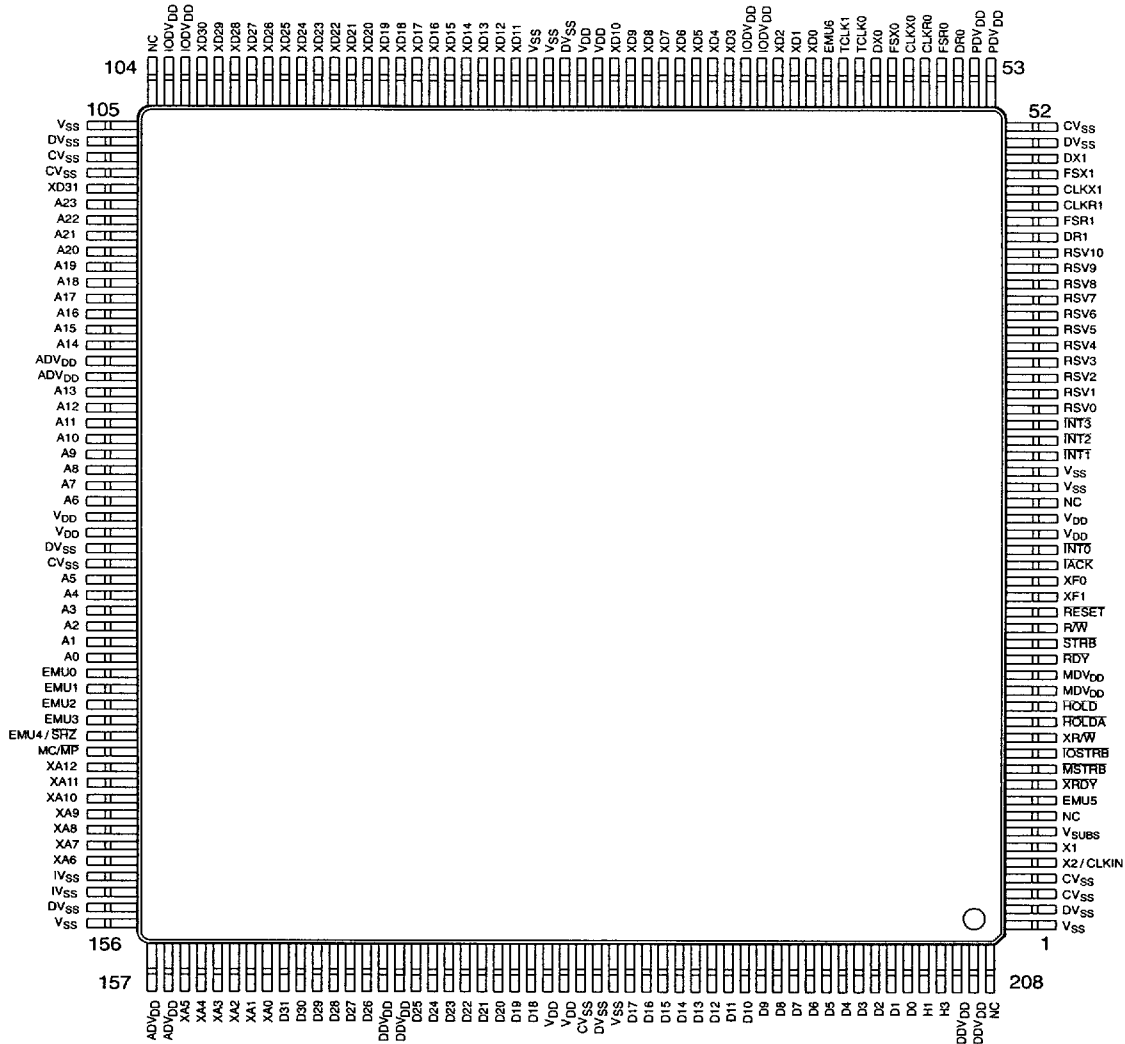
■ 8961722 0099371 203 ■

TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

TMS320C30 PPM pinout and pin assignments

The TMS320C30 PPM device is packaged in a 208-pin plastic quad flatpack (PQFP) JEDEC standard package. The following illustration shows the pinout for this package. The pin assignments are listed in the TMS320C30 PPM pin assignments (alphabetical) table and the TMS320C30 PPM pin assignments (numerical) table.



TMS320C30 PPM Pinout



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

8961722 0099372 14T

TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

TMS320C30 PPM Pin Assignments (Alphabetical) †

PIN		PIN		PIN		PIN		PIN		PIN	
NAME	NO.	NAME	NO.	NAME	NO.	NAME	NO.	NAME	NO.	NAME	NO.
A0	139	CVSS	107	D31	165	INT2	32	TCLK1	62	XD2	66
A1	138	CVSS	108	DDVDD	171	INT3	33	VDD	26	XD3	69
A2	137	CVSS	133	DDVDD	172	IODVDD	67	VDD	27	XD4	70
A3	136	CVSS	183	DDVDD	206	IODVDD	68	VDD	77	XD5	71
A4	135	D0	203	DDVDD	207	IODVDD	102	VDD	78	XD6	72
A5	134	D1	202	DR0	55	IODVDD	103	VDD	130	XD7	73
A6	129	D2	201	DR1	45	IOSTRB	12	VDD	131	XD8	74
A7	128	D3	200	DVSS	2	IVSS	153	VDD	181	XD9	75
A8	127	D4	199	DVSS	51	IVSS	154	VDD	182	XD10	76
A9	126	D5	198	DVSS	105	MCMP	145	VSS	1	XD11	82
A10	125	D6	197	DVSS	106	MDVDD	16	VSS	29	XD12	83
A11	124	D7	196	DVSS	132	MDVDD	17	VSS	30	XD13	84
A12	123	D8	195	DVSS	155	MSTRB	11	VSS	80	XD14	85
A13	122	D9	194	DVSS	156	NC	8	VSS	81	XD15	86
A14	119	D10	193	DVSS	184	NC	28	VSS	105	XD16	87
A15	118	D11	192	DX0	60	NC	104	VSS	156	XD17	88
A16	117	D12	191	DX1	50	NC	208	VSS	185	XD18	89
A17	116	D13	190	EMU0	140	PDVDD	53	VSUBS	7	XD19	90
A18	115	D14	189	EMU1	141	PDVDD	54	X1	6	XD20	91
A19	114	D15	188	EMU2	142	RDY	18	X2/CLKIN	5	XD21	92
A20	113	D16	187	EMU3	143	RESET	21	XA0	164	XD22	93
A21	112	D17	186	EMU4/SHZ	144	RSV0	34	XA1	163	XD23	94
A22	111	D18	180	EMU5	9	RSV1	35	XA2	162	XD24	95
A23	110	D19	179	EMU6	63	RSV2	36	XA3	161	XD25	96
ADVDD	120	D20	178	FSR0	56	RSV3	37	XA4	160	XD26	97
ADVDD	121	D21	177	FSR1	46	RSV4	38	XA5	159	XD27	98
ADVDD	157	D22	176	FSX0	59	RSV5	39	XA6	152	XD28	99
ADVDD	158	D23	175	FSX1	49	RSV6	40	XA7	151	XD29	100
CLKR0	57	D24	174	H1	204	RSV7	41	XA8	150	XD30	101
CLKR1	47	D25	173	H3	205	RSV8	42	XA9	148	XD31	109
CLKX0	58	D26	170	HOLD	15	RSV9	43	XA10	149	XF0	23
CLKX1	48	D27	169	HOLDA	14	RSV10	44	XA11	147	XF1	22
CVSS	3	D28	168	IACK	24	R/W	20	XA12	146	XRDY	10
CVSS	4	D29	167	INT0	25	STRB	19	XD0	64	XR/W	13
CVSS	52	D30	166	INT1	31	TCLK0	61	XD1	65		

† ADVDD, CVSS, DDVDD, DVSS, IODVDD, IVSS, MDVDD, PDVDD, VDD, and VSS pins are on a common plane internal to the device.



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

■ 8961722 0099373 086 ■

TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

TMS320C30 PPM Pin Assignments (Numerical) †

NO.	PIN NAME	NO.	PIN NAME	NO.	PIN NAME	NO.	PIN NAME	NO.	PIN NAME
1	VSS	43	RSV9	85	XD14	127	A8	169	D27
2	DVSS	44	RSV10	86	XD15	128	A7	170	D26
3	CVSS	45	DR1	87	XD16	129	A6	171	DDVDD
4	CVSS	46	FSR1	88	XD17	130	VDD	172	DDVDD
5	X2/CLKIN	47	CLKR1	89	XD18	131	VDD	173	D25
6	X1	48	CLKX1	90	XD19	132	DVSS	174	D24
7	VSUBS	49	FSX1	91	XD20	133	CVSS	175	D23
8	NC	50	DX1	92	XD21	134	A5	176	D22
9	EMU5	51	DVSS	93	XD22	135	A4	177	D21
10	XRDY	52	CVSS	94	XD23	136	A3	178	D20
11	MSTRB	53	PDVDD	95	XD24	137	A2	179	D19
12	IOSTRB	54	PDVDD	96	XD25	138	A1	180	D18
13	XRW	55	DR0	97	XD26	139	A0	181	VDD
14	HOLDA	56	FSR0	98	XD27	140	EMU0	182	VDD
15	HOLD	57	CLKR0	99	XD28	141	EMU1	183	CVSS
16	MDVDD	58	CLKX0	100	XD29	142	EMU2	184	DVSS
17	MDVDD	59	FSX0	101	XD30	143	EMU3	185	VSS
18	RDY	60	DX0	102	IODVDD	144	EMU4/SHZ	186	D17
19	STRB	61	TCLK0	103	IODVDD	145	MC/MP	187	D16
20	RW	62	TCLK1	104	NC	146	XA12	188	D15
21	RESET	63	EMU6	105	VSS	147	XA11	189	D14
22	XF1	64	XD0	106	DVSS	148	XA10	190	D13
23	XF0	65	XD1	107	CVSS	149	XA9	191	D12
24	IACK	66	XD2	108	CVSS	150	XA8	192	D11
25	INT0	67	IODVDD	109	XD31	151	XA7	193	D10
26	VDD	68	IODVDD	110	A23	152	XA6	194	D9
27	VDD	69	XD3	111	A22	153	IVSS	195	D8
28	NC	70	XD4	112	A21	154	IVSS	196	D7
29	VSS	71	XD5	113	A20	155	DVSS	197	D6
30	VSS	72	XD6	114	A19	156	VSS	198	D5
31	INT1	73	XD7	115	A18	157	ADVDD	199	D4
32	INT2	74	XD8	116	A17	158	ADVDD	200	D3
33	INT3	75	XD9	117	A16	159	XA5	201	D2
34	RSV0	76	XD10	118	A15	160	XA4	202	D1
35	RSV1	77	VDD	119	A14	161	XA3	203	D0
36	RSV2	78	VDD	120	ADVDD	162	XA2	204	H1
37	RSV3	79	DVSS	121	ADVDD	163	XA1	205	H3
38	RSV4	80	VSS	122	A13	164	XA0	206	DDVDD
39	RSV5	81	VSS	123	A12	165	D31	207	DDVDD
40	RSV6	82	XD11	124	A11	166	D30	208	NC
41	RSV7	83	XD12	125	A10	167	D29		
42	RSV8	84	XD13	126	A9	168	D28		

† ADVDD, CVSS, DDVDD, DVSS, IODVDD, IVSS, MDVDD, PDVDD, VDD, and VSS pins are on a common plane internal to the device.



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

pin functions

This section provides signal descriptions for the TMS320C30 in the microprocessor mode. The following tables list each signal, the number of pins, type of operating mode(s) (that is, input, output, or high-impedance state as indicated by I, O, or Z), and a brief description of its function. All pins labeled NC have special functions and should not be connected by the user. A line over a signal name (for example, $\overline{\text{RESET}}$) indicates that the signal is active low (true at logic 0 level). The signals are grouped according to function.

TMS320C30 Pin Functions

PIN NAME	QTY [‡]	TYPE [†]	DESCRIPTION	CONDITIONS WHEN SIGNAL IS Z TYPE [§]
PRIMARY BUS INTERFACE				
D31–D0	32	I/O/Z	32-bit data port of the primary bus interface	S H R
A23–A0	24	O/Z	24-bit address port of the primary bus interface	S H R
$\overline{\text{R/W}}$	1	O/Z	Read/write for primary bus interface. $\overline{\text{R/W}}$ is high when a read is performed and low when a write is performed over the parallel interface.	S H R
$\overline{\text{STRB}}$	1	O/Z	External access strobe for the primary bus interface	S H
$\overline{\text{RDY}}$	1	I	Ready. $\overline{\text{RDY}}$ indicates that the external device is prepared for a primary-bus-interface transaction to complete.	
$\overline{\text{HOLD}}$	1	I	Hold for primary bus interface. When $\overline{\text{HOLD}}$ is a logic low, any ongoing transaction is completed. A23–A0, D31–D0, $\overline{\text{STRB}}$, and $\overline{\text{R/W}}$ are in the high-impedance state and all transactions over the primary bus interface are held until $\overline{\text{HOLD}}$ becomes a logic high or the NOHOLD bit of the primary-bus-control register is set.	
$\overline{\text{HOLDA}}$	1	O/Z	Hold acknowledge for primary bus interface. $\overline{\text{HOLDA}}$ is generated in response to a logic low on $\overline{\text{HOLD}}$. $\overline{\text{HOLDA}}$ indicates that A23–A0, D31–D0, $\overline{\text{STRB}}$, and $\overline{\text{R/W}}$ are in the high-impedance state and that all transactions over the bus are held. $\overline{\text{HOLDA}}$ is high in response to a logic high of $\overline{\text{HOLD}}$ or when the NOHOLD bit of the primary-bus-control register is set.	S
EXPANSION BUS INTERFACE				
XD31–XD0	32	I/O/Z	32-bit data port of the expansion bus interface	S R
XA12–XA0	13	O/Z	13-bit address port of the expansion bus interface	S R
$\overline{\text{XR/W}}$	1	O/Z	Read/write signal for expansion bus interface. When a read is performed, $\overline{\text{XR/W}}$ is held high; when a write is performed, $\overline{\text{XR/W}}$ is low.	S R
$\overline{\text{MSTRB}}$	1	O/Z	External memory access strobe for the expansion bus interface	S
$\overline{\text{IOSTRB}}$	1	O/Z	External I/O access strobe for the expansion bus interface	S
$\overline{\text{XRDY}}$	1	I	Ready signal. $\overline{\text{XRDY}}$ indicates that the external device is prepared for an expansion-bus-interface transaction to complete.	
CONTROL SIGNALS				
$\overline{\text{RESET}}$	1	I	Reset. When $\overline{\text{RESET}}$ is a logic low, the device is in the reset condition. When $\overline{\text{RESET}}$ becomes a logic high, execution begins from the location specified by the reset vector.	
$\overline{\text{INT3}}\text{--}\overline{\text{INT0}}$	4	I	External interrupts	
$\overline{\text{IACK}}$	1	O/Z	Interrupt acknowledge. $\overline{\text{IACK}}$ is generated by the IACK instruction. $\overline{\text{IACK}}$ can be used to indicate the beginning or end of an interrupt-service routine.	S
MC/MP	1	I	Microcomputer/microprocessor mode	
XF1, XF0	2	I/O/Z	External flags. XF1 and XF0 are used as general-purpose I/Os or to support interlocked processor instructions.	S R

[†] I = input, O = output, Z = high-impedance state. All pins labeled NC have specified functions and should not be connected by the user

[‡] Quantity is the same for GEL and PPM packages unless otherwise noted.

[§] S = SHZ active, H = HOLD active, R = RESET active



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

■ 8961722 0099375 959 ■

TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

TMS320C30 Pin Functions (Continued)

NAME	PIN QTY‡	TYPE†	DESCRIPTION	CONDITIONS WHEN SIGNAL IS Z TYPE§	
SERIAL PORT 0 SIGNALS					
CLKX0	1	I/O/Z	Serial port 0 transmit clock. CLKX0 is the serial shift clock for the serial port 0 transmitter.	S	R
DX0	1	I/O/Z	Data transmit output. Serial port 0 transmits serial data on DX0.	S	R
FSX0	1	I/O/Z	Frame synchronization pulse for transmit. The FSX0 pulse initiates the transmit data process over DX0.	S	R
CLKR0	1	I/O/Z	Serial port 0 receive clock. CLKR0 is the serial shift clock for the serial port 0 receiver.	S	R
DR0	1	I/O/Z	Data receive. Serial port 0 receives serial data on DR0.	S	R
FSR0	1	I/O/Z	Frame synchronization pulse for receive. The FSR0 pulse initiates the receive data process over DR0.	S	R
SERIAL PORT 1 SIGNALS					
CLKX1	1	I/O/Z	Serial port 1 transmit clock. CLKX1 is the serial shift clock for the serial port 1 transmitter.	S	R
DX1	1	I/O/Z	Data transmit output. Serial port 1 transmits serial data on DX1.	S	R
FSX1	1	I/O/Z	Frame synchronization pulse for transmit. The FSX1 pulse initiates the transmit data process over DX1.	S	R
CLKR1	1	I/O/Z	Serial port 1 receive clock. CLKR1 is the serial shift clock for the serial port 1 receiver.	S	R
DR1	1	I/O/Z	Data receive. Serial port 1 receives serial data on DR1.	S	R
FSR1	1	I/O/Z	Frame synchronization pulse for receive. The FSR1 pulse initiates the receive data process over DR1.	S	R
TIMER 0 SIGNAL					
TCLK0	1	I/O/Z	Timer clock 0. As an input, TCLK0 is used by timer 0 to count external pulses. As an output, TCLK0 outputs pulses generated by timer 0.	S	R
TIMER 1 SIGNAL					
TCLK1	1	I/O/Z	Timer clock 1. As an input, TCLK1 is used by timer 1 to count external pulses. As an output, TCLK1 outputs pulses generated by timer 1.	S	R
SUPPLY AND OSCILLATOR SIGNALS					
	GEL	PPM			
V _{DD}	4	8	I	5 V supply¶	
IODV _{DD}	2	4	I	5 V supply¶	
ADV _{DD}	2	4	I	5 V supply¶	
PDV _{DD}	1	2	I	5 V supply¶	
DDV _{DD}	2	4	I	5 V supply¶	
MDV _{DD}	1	2	I	5 V supply¶	
V _{SS}	4	8	I	Ground	
DV _{SS}	4	8	I	Ground	
CV _{SS}	2	4	I	Ground	
IV _{SS}	2	1	I	Ground	

† I = input, O = output, Z = high-impedance state. All pins labeled NC have special functions and should not be connected by the user.

‡ Quantity is the same for GEL and PPM packages unless otherwise noted.

§ S = $\overline{\text{SHZ}}$ active, H = HOLD active, R = RESET active

¶ Recommended decoupling capacitor is 0.1 μF .



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

TMS320C30
DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

TMS320C30 Pin Functions (Continued)

NAME	PIN QTY‡	TYPE†	DESCRIPTION	CONDITIONS WHEN SIGNAL IS Z TYPE§
SUPPLY AND OSCILLATOR SIGNALS (CONTINUED)				
VBBP	1	NC	V _{BB} pump oscillator output	
VSUBS	1	I	Substrate terminal. Tie to ground.	
X1	1	O	Output from the internal oscillator for the crystal. If a crystal is not used, X1 should be left unconnected.	
X2/CLKIN	1	I	Input to the internal oscillator from the crystal or a clock	
H1	1	O/Z	External H1 clock. H1 has a period equal to twice CLKIN.	S
H3	1	O/Z	External H3 clock. H3 has a period equal to twice CLKIN.	S
RESERVED¶				
EMU0–EMU2	3	I	Reserved. Use pullup resistors to 5 V.	
EMU3	1	O/Z	Reserved	S
EMU4/ $\overline{\text{SHZ}}$	1	I	Shutdown high impedance. When active, EMU4/ $\overline{\text{SHZ}}$ shuts down the TMS320C30 and places all pins in the high-impedance state. EMU4/ $\overline{\text{SHZ}}$ is used for board-level testing to ensure that no dual-drive conditions occur. CAUTION: A low on $\overline{\text{SHZ}}$ corrupts TMS320C30 memory and register contents. Reset the device with $\overline{\text{SHZ}}$ high to restore it to a known operating condition.	
EMU5, EMU6	2	NC	Reserved	
RSV10–RSV5	6	I/O	Reserved. Use pullup resistors to 5 V.	
RSV4–RSV0	5	I	Reserved. Tie pins directly to 5 V.	
Locator	1#	NC	Reserved	

† I = input, O = output, Z = high-impedance state. All pins labeled NC have special functions and should not be connected by the user.

‡ Quantity is the same for GEL and PPM packages unless otherwise noted.

§ S = $\overline{\text{SHZ}}$ active, H = HOLD active, R = RESET active

¶ Follow the connections specified for the reserved pins. Use 18-k Ω –22-k Ω pullup resistors for best results. All 5-V supply pins must be connected to a common supply plane, and all ground pins must be connected to a common ground plane.

For the GEL package only. There is no locator in the PPM package.



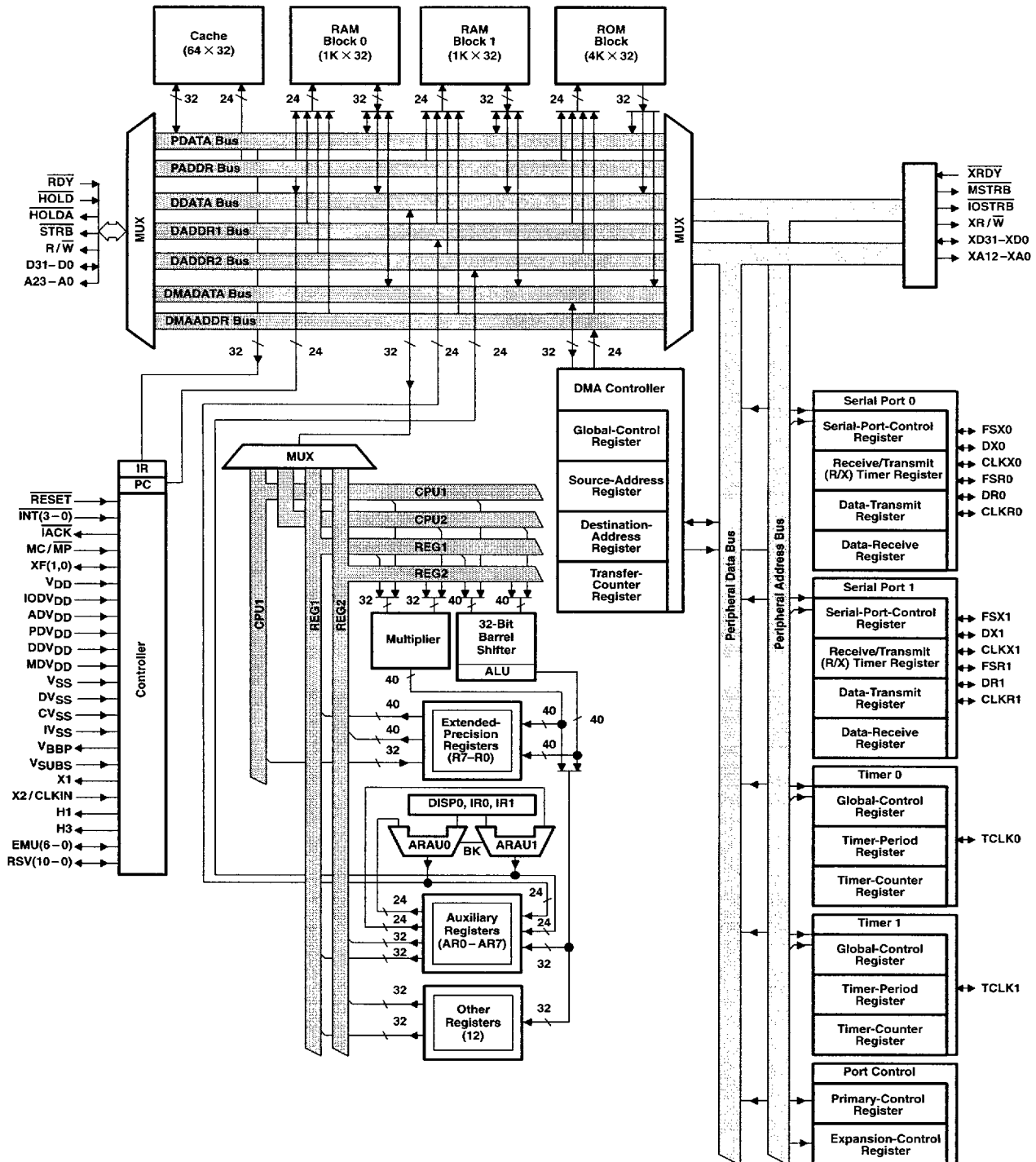
POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

■ 8961722 0099377 721 ■

TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

functional block diagram



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

8961722 0099378 668

memory map

Figure 1 depicts the memory map for the TMS320C30. Refer to the *TMS320C3x User's Guide* (literature number SPRU031) for a detailed description of this memory mapping. Figure 2 shows the reset, interrupt, and trap vector/branches memory-map locations. Figure 3 shows the peripheral bus memory-mapped registers.

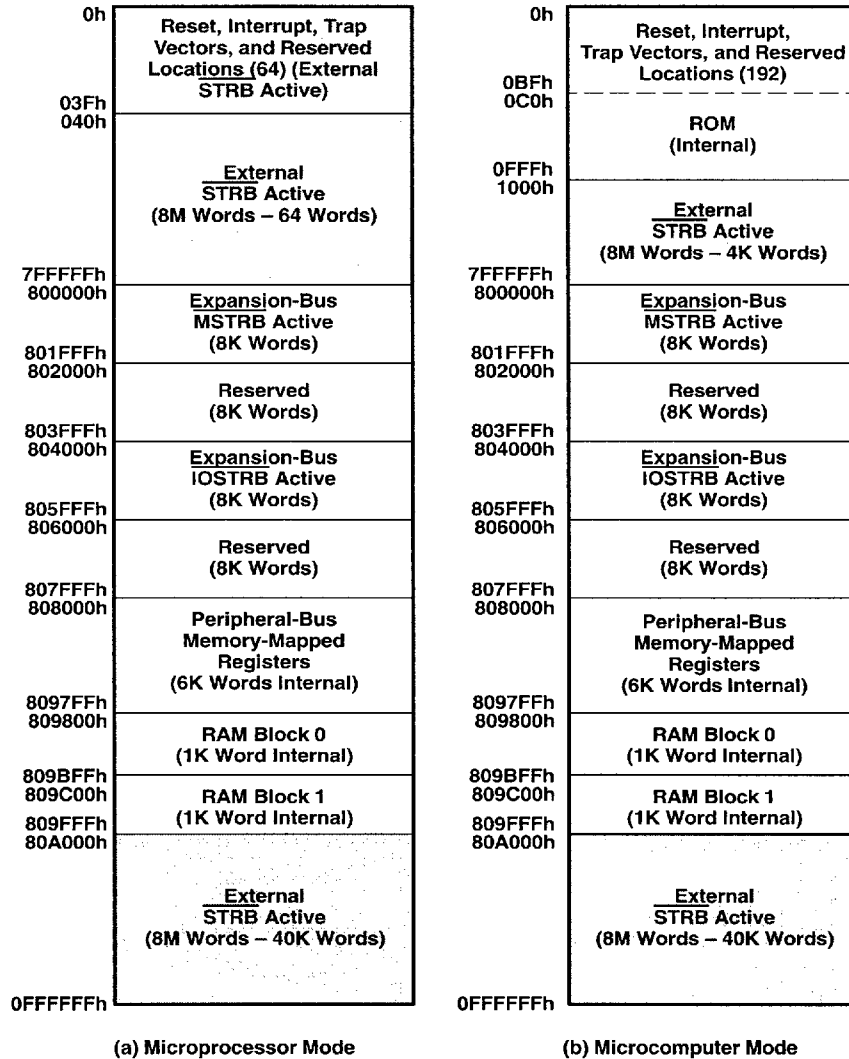


Figure 1. TMS320C30 Memory Map



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

8961722 0099379 5T4

**TMS320C30
DIGITAL SIGNAL PROCESSOR**

SPRS032A – APRIL 1996 – REVISED JUNE 1997

memory map (continued)

00h	Reset
01h	INT0
02h	INT1
03h	INT2
04h	INT3
05h	XINT0
06h	RINT0
07h	XINT1
08h	RINT1
09h	TINT0
0Ah	TINT1
0Bh	DINT
0Ch	Reserved
1Fh	
20h	
	TRAP 0
	.
	.
	.
3Bh	TRAP 27
3Ch	Reserved
3Fh	

(a) Microprocessor Mode

00h	Reset
01h	INT0
02h	INT1
03h	INT2
04h	INT3
05h	XINT0
06h	RINT0
07h	XINT1
08h	RINT1
09h	TINT0
0Ah	TINT1
0Bh	DINT
0Ch	Reserved
1Fh	
20h	
	TRAP 0
	.
	.
	.
3Bh	TRAP 27
3Ch	Reserved
BFh	

(a) Microcomputer Mode

Figure 2. Reset, Interrupt, and Trap Vector/Branches Memory-Map Locations



memory map (continued)

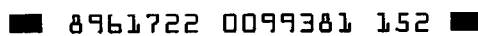
808000h	DMA Global Control
808004h	DMA Source Address
808006h	DMA Destination Address
808008h	DMA Transfer Counter
808020h	Timer 0 Global Control
808024h	Timer 0 Counter
808028h	Timer 0 Period
808030h	Timer 1 Global Control
808034h	Timer 1 Counter
808038h	Timer 1 Period Register
808040h	Serial Port 0 Global Control
808042h	FSX/DX/CLKX Serial Port 0 Control
808043h	FSR/DR/CLKR Serial Port 0 Control
808044h	Serial Port 0 R/X Timer Control
808045h	Serial Port 0 R/X Timer Counter
808046h	Serial Port 0 R/X Timer Period
808048h	Serial Port 0 Data Transmit
80804Ch	Serial Port 0 Data Receive
808050h	Serial Port 1 Global Control
808052h	FSX/DX/CLKX Serial Port 1 Control
808053h	FSR/DR/CLKR Serial Port 1 Control
808054h	Serial Port 1 R/X Timer Control
808055h	Serial Port 1 R/X Timer Counter
808056h	Serial Port 1 R/X Timer Period
808058h	Serial Port 1 Data Transmit
80805Ch	Serial Port 1 Data Receive
808060h	Expansion-Bus Control
808064h	Primary-Bus Control

†Shading denotes reserved address locations

Figure 3. Peripheral Bus Memory-Mapped Registers †



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443



TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

absolute maximum ratings over specified temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} (see Note 1)	–0.3 V to 7 V
Input voltage range, V_I	–0.3 V to 7 V
Output voltage range, V_O	–0.3 V to 7 V
Continuous power dissipation (see Note 2)	3.15 W
Operating case temperature range, T_C	0°C to 85°C
Storage temperature range, T_{stg}	–55°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, a functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltage values are with respect to V_{SS} .
 2. Actual operating power is less. This value is obtained under specially produced worst-case test conditions, which are not sustained during normal device operation. These conditions consist of continuous parallel writes of a checkerboard pattern to both primary and extension buses at the maximum rate possible. See normal (I_{CC}) current specification in the electrical characteristics table and also read *Calculation of TMS320C30 Power Dissipation Application Report* (literature number SPRA020).

recommended operating conditions (see Note 3)

		MIN	NOM‡	MAX	UNIT
V_{DD}	Supply voltage (AV_{DD} , etc.)	4.75	5	5.25	V
V_{SS}	Supply voltage (CV_{SS} , etc.)		0		V
V_{IH}	High-level input voltage	All other pins	2	$V_{DD} + 0.3§$	V
		CLKIN	2.6	$V_{DD} + 0.3§$	
V_{IL}	Low-level input voltage	–0.3§		0.8	V
I_{OH}	High-level output current			–300	µA
I_{OL}	Low-level output current			2	mA
T_C	Operating case temperature	0		85	°C

‡ All nominal values are at $V_{DD} = 5$ V, T_A (ambient air temperature) = 25°C.

§ These values are derived from characterization and not tested.

NOTE 3: All input and output voltage levels are TTL-compatible.



TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

**electrical characteristics over recommended ranges of supply voltage (unless otherwise noted)
(see Note 3)**

PARAMETER		TEST CONDITIONS†	MIN	TYP‡	MAX	UNIT
V _{OH}	High-level output voltage	V _{DD} = MIN, I _{OH} = MAX	2.4	3		V
V _{OL}	Low-level output voltage	V _{DD} = MIN, I _{OL} = MAX		0.3	0.6§	V
I _Z	High-impedance current	V _{DD} = MAX	- 20		20	µA
I _I	Input current	V _I = V _{SS} to V _{DD}	- 10		10	µA
I _{IP}	Input current	Inputs with internal pullups (see Note 4)	- 600		20	µA
I _{CC}	Supply current	T _A = 25°C, V _{DD} = MAX, t _c (CI) = MIN, See Note 5	'320C30-27	130	600	mA
			'320C30-33	150	600	
			'320C30-40	175	600	
			'320C30-50	200	600	
C _i	Input capacitance	CLKIN			25	pF
		All other inputs			15	
C _o	Output capacitance				20¶	pF

† For conditions shown as MIN/MAX, use the appropriate value specified in recommended operating conditions.

‡ All typical values are at V_{DD} = 5 V, T_A (ambient air temperature) = 25°C.

§ These values are derived from characterization but not tested.

¶ These values are derived by design but not tested.

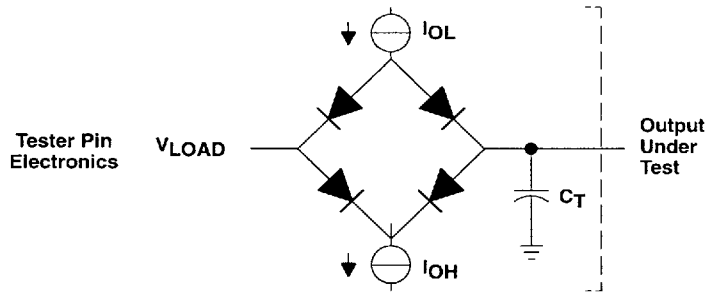
- NOTES:
- All input and output voltage levels are TTL-compatible.
 - Pins with internal pullup devices: INTO–INT3, MC/MP, RSV0–RSV10. Although RSV0–RSV10 have internal pullup devices, external pullups should be used on each pin as identified in the pin functions tables.
 - Actual operating current is less than this maximum value. This value is obtained under specially produced worst-case test conditions, which are not sustained during normal device operation. These conditions consist of continuous parallel writes of a checkerboard pattern to both primary and expansion buses at the maximum rate possible. See *Calculation of TMS320C30 Power Dissipation Application Report* (literature number SPRA020).



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

■ 8961722 0099383 T25 ■

PARAMETER MEASUREMENT INFORMATION



Where: I_{OL} = 2 mA (all outputs)
 I_{OH} = 300 μ A (all outputs)
 V_{LOAD} = 2.15 V
 C_T = 80-pF typical load-circuit capacitance

Figure 4. Test Load Circuit

signal transition levels

TTL-level outputs are driven to a minimum logic-high level of 2.4 V and to a maximum logic-low level of 0.6 V. Output transition times are specified as follows (see Figure 5):

- For a high-to-low transition on a TTL-compatible output signal, the level at which the output is said to be no longer high is 2 V and the level at which the output is said to be low is 1 V.
- For a low-to-high transition, the level at which the output is said to be no longer low is 1 V and the level at which the output is said to be high is 2 V.

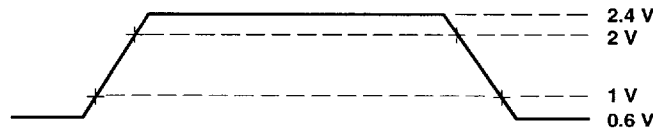


Figure 5. TTL-Level Outputs

Transition times for TTL-compatible inputs are specified as follows (see Figure 6):

- For a high-to-low transition on an input signal, the level at which the input is said to be no longer high is 2 V and the level at which the input is said to be low is 0.8 V.
- For a low-to-high transition on an input signal, the level at which the input is said to be no longer low is 0.8 V and the level at which the input is said to be high is 2 V.

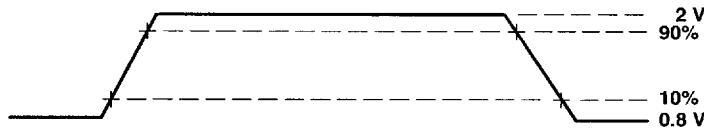


Figure 6. TTL-Level Inputs

PARAMETER MEASUREMENT INFORMATION

timing parameter symbology

Timing parameter symbols used herein were created in accordance with JEDEC Standard 100-A. In order to shorten the symbols, some of the pin names and other related terminology have been abbreviated as follows, unless otherwise noted:

A	(L)A30–(L)A0 or (L)Ax	IOS	$\overline{\text{IOSTRB}}$
ASYNCH	Asynchronous reset signals in the high-impedance state	(M)S	$\overline{\text{(M)STRB}}$, includes $\overline{\text{STRB}}$ and $\overline{\text{MSTRB}}$
CH	CLKX0 and CLKX1	RDY	$\overline{\text{RDY}}$
CI	CLKIN	RESET	$\overline{\text{RESET}}$
CLKR	CLKR0 and CLKR1	RW	$\text{R}/\overline{\text{W}}$
CONTROL	Control signals	S	$\overline{\text{(M)S}}$, which includes $\overline{\text{MSTRB}}$, $\overline{\text{STRB}}$; and IOS, $\overline{\text{IOSTRB}}$
D	D31–D0 or Dx	SCK	CLKX/R, includes CLKX0, CLKX1, CLKR0, and CLKR1
DR	DR0 and DR1	TCLK	TCLK0 and TCLK1
DX	DX0 and DX1	XA	XA12–XA0 or XAx
FS	FSX/R, includes FSX0, FSX1, FSR0, and FSR1	(X)A	Includes A23–A0 and XA12–XA0
FSR	FSR0 and RSR1	XD	XD31–XD0 or XDx
FSX	FSX0 and FSX1	(X)D	Includes D31–D0 and XD31–XD0
GPIO	General-purpose input/output (peripheral pins include CLKX0/1, CLKR0/1, DX0/1, DR0/1, FSX0/1, FSR0/1, TCLK0/1)	XF	XFx, includes XF0 and XF1
H	H1 and H3	XF0	XF0
H1	H1	XF1	XF1
H3	H3	XFIO	XFx switching from input to output
HOLD	$\overline{\text{HOLD}}$	XRDY	$\overline{\text{XRDY}}$
HOLDA	$\overline{\text{HOLDA}}$	(X)RDY	$\overline{\text{(X)RDY}}$, includes $\overline{\text{RDY}}$ and $\overline{\text{XRDY}}$
IACK	$\overline{\text{IACK}}$	XRW	$\text{XR}/\overline{\text{W}}$
INT	$\overline{\text{INT3}}$ – $\overline{\text{INT0}}$	(X)RW	$\overline{\text{(X)R}/\overline{\text{W}}}$, includes $\overline{\text{R}/\overline{\text{W}}}$ and $\overline{\text{XR}/\overline{\text{W}}}$



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

X2/CLKIN, H1, and H3 timing

The following table defines the timing parameters for the X2/CLKIN, H1, and H3 interface signals. The numbers shown in Figure 7 and Figure 8 correspond with those in the NO. column of the table below. Refer to the $\overline{\text{RESET}}$ timing in Figure 19 for CLKIN to H1 and H3 delay specification.

timing parameters for X2/CLKIN, H1, H3 (see Figure 7 and Figure 8)

NO.		'C30-27		'C30-33		'C30-40		'C30-50		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
1	$t_f(\text{Cl})$ Fall time, CLKIN		6†		5†		5†		5†	ns
2	$t_w(\text{ClL})$ Pulse duration, CLKIN low $t_c(\text{Cl}) = \text{min}$	14		10		9		7		ns
3	$t_w(\text{ClH})$ Pulse duration, CLKIN high $t_c(\text{Cl}) = \text{min}$	14		10		9		7		ns
4	$t_r(\text{Cl})$ Rise time, CLKIN		6†		5†		5†		5†	ns
5	$t_c(\text{Cl})$ Cycle time, CLKIN	37	303	30	303	25	303	20	303	ns
6	$t_f(\text{H})$ Fall time, H1 and H3		4		3		3		3	ns
7	$t_w(\text{HL})$ Pulse duration, H1 and H3 low	P-6†		P-6†		P-5†		P-5†		ns
8	$t_w(\text{HH})$ Pulse duration, H1 and H3 high	P-7†		P-7†		P-6†		P-6†		ns
9	$t_r(\text{H})$ Rise time, H1 and H3		5		4		3		3	ns
9.1	$t_d(\text{HL-HH})$ Delay time, from H1 low to H3 high or from H3 low to H1 high	0	6	0	5	0	4	0	4	ns
10	$t_c(\text{H})$ Cycle time, H1 and H3	74	606	60	606	50	606	40	606	ns

† Specified by design but not tested

‡ P = $t_c(\text{Cl})$

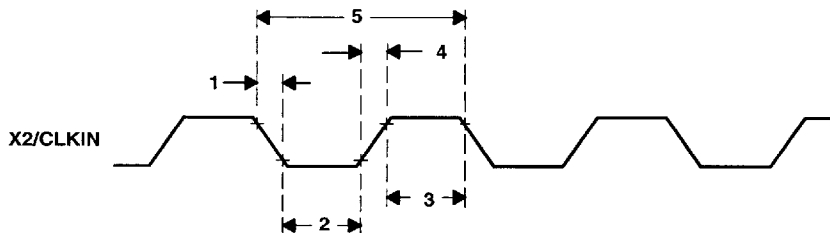


Figure 7. Timing for X2/CLKIN

X2/CLKIN, H1, and H3 timing (continued)

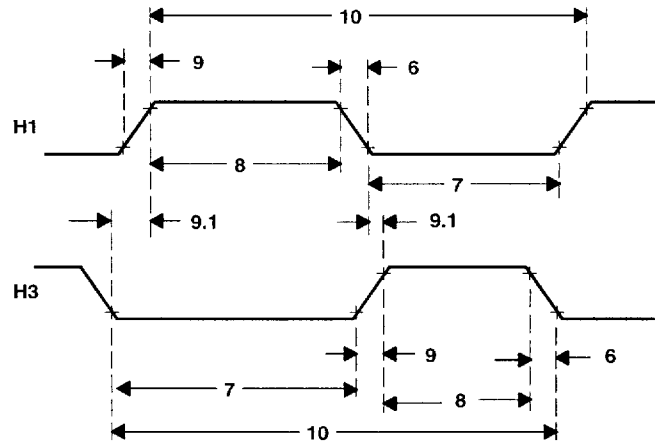
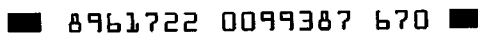


Figure 8. Timing for H1 and H3



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443



**TMS320C30
DIGITAL SIGNAL PROCESSOR**

SPRS032A - APRIL 1996 - REVISED JUNE 1997

memory read/write timing

The following table defines memory read/write timing parameters for (M)STRB. The numbers shown in Figure 9 and Figure 10 correspond with those in the NO. column of the table.

timing parameters for a memory [(M)STRB = 0] read/write (see Figure 9 and Figure 10)

NO.	Description	'C30-27		'C30-33		'C30-40		'C30-50		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
11	t _d [H1L-(M)SL] Delay time, H1 low to (M)STRB low	0†	13	0†	10	0†	6‡	0†	4	ns
12	t _d [H1L-(M)SH] Delay time, H1 low to (M)STRB high	0†	13	0†	10	0†	6	0†	4	ns
13.1	t _d (H1H-RWL) Delay time, H1 high to RW low	0†	13	0†	10	0†	9	0†	7	ns
13.2	t _d (H1H-XRWL) Delay time, H1 high to XRW low	0†	19	0†	15	0†	13	0†	11	ns
14.1	t _d (H1L-A) Delay time, H1 low to A valid	0†	16	0†	14	0†	11	0†	9	ns
14.2	t _d (H1L-XA) Delay time, H1 low to XA valid	0†	12	0†	10	0†	9	0†	8	ns
15.1	t _{su} (D-H1L)R Setup time, D before H1 low (read)	18		16		14		10		ns
15.2	t _{su} (XD-H1L)R Setup time, XD before H1 low (read)	21		18		16		14		ns
16	t _h [H1L-(X)DIR] Hold time, (X)D after H1 low (read)	0		0		0		0		ns
17.1	t _{su} (RDY-H1H) Setup time, RDY before H1 high	10		8		8		6		ns
17.2	t _{su} (XRDY-H1H) Setup time, XRDY before H1 high	11		9		9		8		ns
18	t _h [H1H-(X)RDY] Hold time, (X)RDY after H1 high	0		0		0		0		ns
19	t _d [H1H-(X)RWH]W Delay time, H1 high to (X)RW high (write)	13		10		9		7		ns
20	t _v [H1L-(X)DIW] Valid time, (X)D after H1 low (write)	25		20		17		14		ns
21	t _h [H1H-(X)DIW] Hold time, (X)D after H1 high (write)	0†		0†		0†		0†		ns
22.1	t _d (H1H-A)W Delay time, H1 high to A valid on back-to-back write cycles (write)	23		18		15		12		ns
22.2	t _d (H1H-XA)W Delay time, H1 high to XA valid on back-to-back write cycles (write)	32		25		21		18		ns
26	t _d [A-(X)RDY] Delay time, (X)RDY from A valid	10§		8§		7§		6		ns

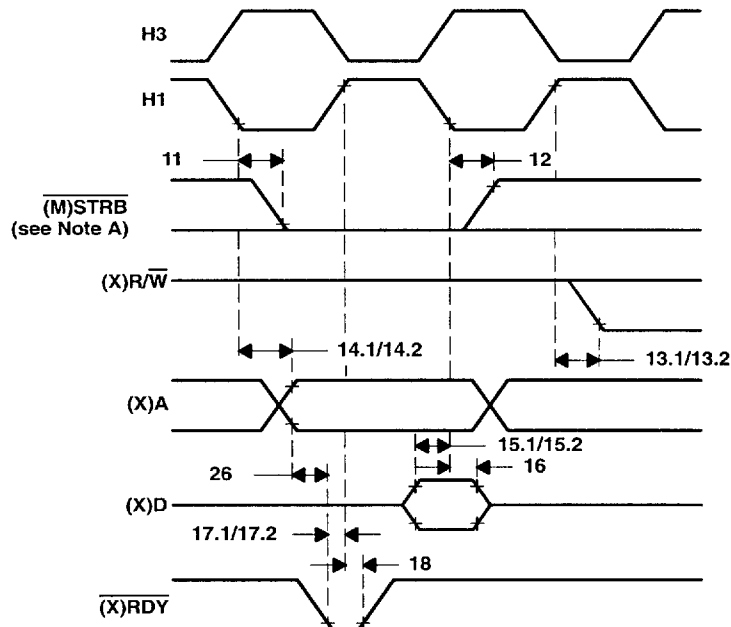
† Specified by design but not tested
 ‡ For 'C30 PPM, t_d[H1L-(M)SL] (max)=7 ns
 § This value is characterized but not tested



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

8961722 0099388 507

memory read/write timing (continued)



NOTE A: $(\overline{M})\text{STRB}$ remains low during back-to-back read operations.

Figure 9. Timing for Memory [$(\overline{M})\text{STRB} = 0$] Read

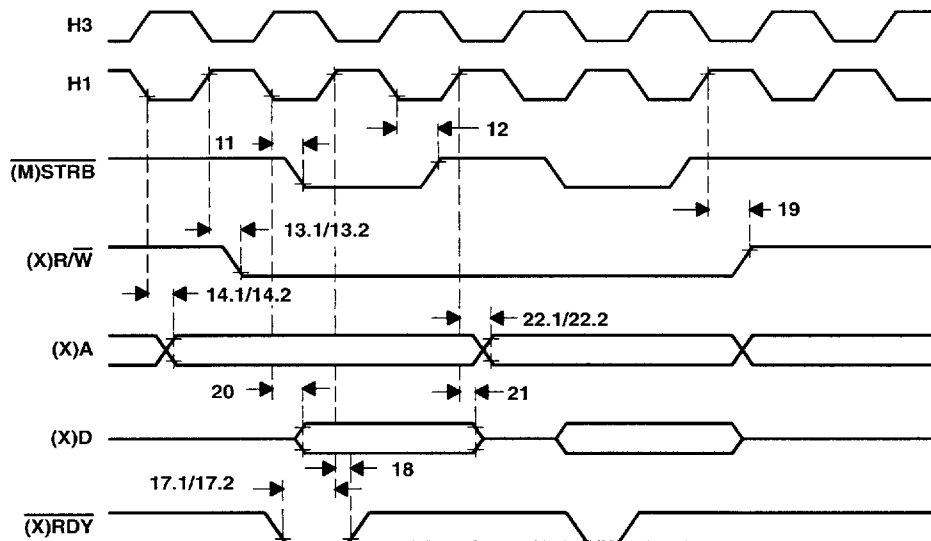


Figure 10. Timing for Memory [$(\overline{M})\text{STRB} = 0$] Write



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

8961722 0099389 443

TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

memory read/write timing (continued)

The following table defines memory read timing parameters for $\overline{\text{IOSTRB}}$. The numbers shown in Figure 11 correspond with those in the NO. column of the table below.

timing parameters for a memory ($\overline{\text{IOSTRB}} = 0$) read (see Figure 11)

NO.		'C30-27		'C30-33		'C30-40		'C30-50		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
11.1	$t_{d(H1H\text{-}IO\text{SL})}$ Delay time, H1 high to $\overline{\text{IOSTRB}}$ low	0†	13	0†	10	0†	9	0†	8	ns
12.1	$t_{d(H1H\text{-}IO\text{SH})}$ Delay time, H1 high to $\overline{\text{IOSTRB}}$ high	0†	13	0†	10	0†	9	0†	8	ns
13.1	$t_{d(H1L\text{-}XR\text{WH})}$ Delay time, H1 low to $\overline{\text{XR/W}}$ high	0†	13	0†	10	0†	9	0	8	ns
14.3	$t_{d(H1L\text{-}XA)}$ Delay time, H1 low to XA valid	0†	13	0†	10	0†	9	0†	8	ns
15.3	$t_{su(XD\text{-}H1H)R}$ Setup time, XD before H1 high (read)	19		15		13		11		ns
16.1	$t_{hH1H\text{-}XD)R}$ Hold time, XD after H1 high (read)	0		0		0		0		ns
17.3	$t_{su(XRDY\text{-}H1H)}$ Setup time, $\overline{\text{XRDY}}$ before H1 high	11		9		9		8		ns
18.1	$t_{h(H1H\text{-}XRDY)}$ Hold time, $\overline{\text{XRDY}}$ after H1 high	0		0		0		0		ns
23	$t_{d(H1L\text{-}XR\text{WL})}$ Delay time, H1 low to $\overline{\text{XR/W}}$ low	0†	19	0†	15	0†	13	0†	11	ns

† This value is characterized but not tested

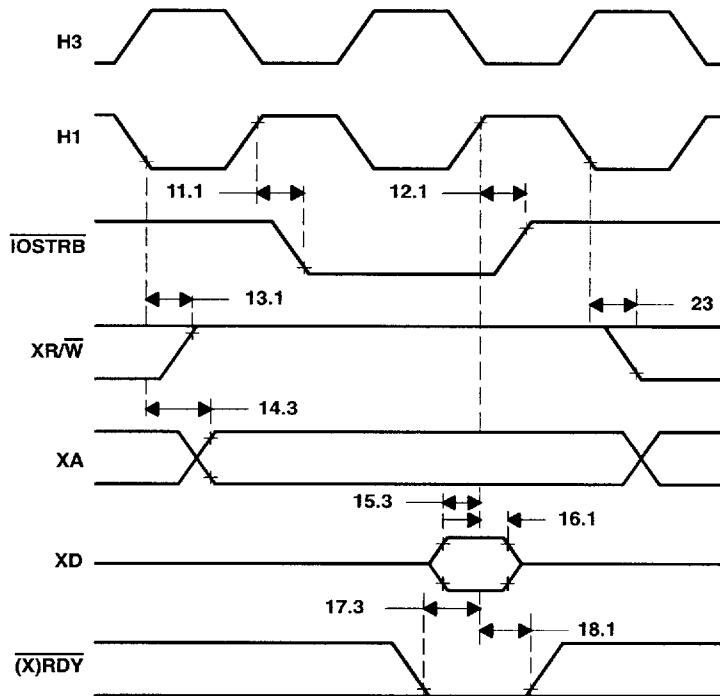


Figure 11. Timing for Memory ($\overline{\text{IOSTRB}} = 0$) Read

memory read/write timing (continued)

The following table defines memory write timing parameters for $\overline{\text{IOSTRB}}$. The numbers shown in Figure 12 correspond with those in the NO. column of the table below.

timing parameters for a memory ($\overline{\text{IOSTRB}} = 0$) write (see Figure 12)

NO.		'C30-27		'C30-33		'C30-40		'C30-50		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
11.1	$t_{d(H1H\text{-}IOSL)$ Delay time, H1 high to $\overline{\text{IOSTRB}}$ low	0†	13	0†	10	0†	9	0†	8	ns
12.1	$t_{d(H1H\text{-}IOSH)$ Delay time, H1 high to $\overline{\text{IOSTRB}}$ high	0†	13	0†	10	0†	9	0†	8	ns
13.1	$t_{d(H1L\text{-}XRWH)$ Delay time, H1 low to $\overline{\text{XR/W}}$ high	0†	13	0†	10	0†	9	0	8	ns
14.3	$t_{d(H1L\text{-}XA)$ Delay time, H1 low to XA valid	0†	13	0†	10	0†	9	0†	8	ns
17.3	$t_{su(XRDY\text{-}H1H)$ Setup time, $\overline{\text{XRDY}}$ before H1 high	11		9		9		8		ns
18.1	$t_h(H1H\text{-}XRDY)$ Hold time, $\overline{\text{XRDY}}$ after H1 high	0		0		0		0		ns
23	$t_{d(H1L\text{-}XRWL)$ Delay time, H1 low to $\overline{\text{XR/W}}$ low	0†	19	0†	15	0†	13	0†	11	ns
24	$t_v(H1H\text{-}XD)W$ Valid time, (X)D after H1 high (write)		38		30		25		20	ns
25	$t_h(H1L\text{-}XD)W$ Hold time, (X)D after H1 low (write)	0		0		0		0		ns

† This value is characterized but not tested

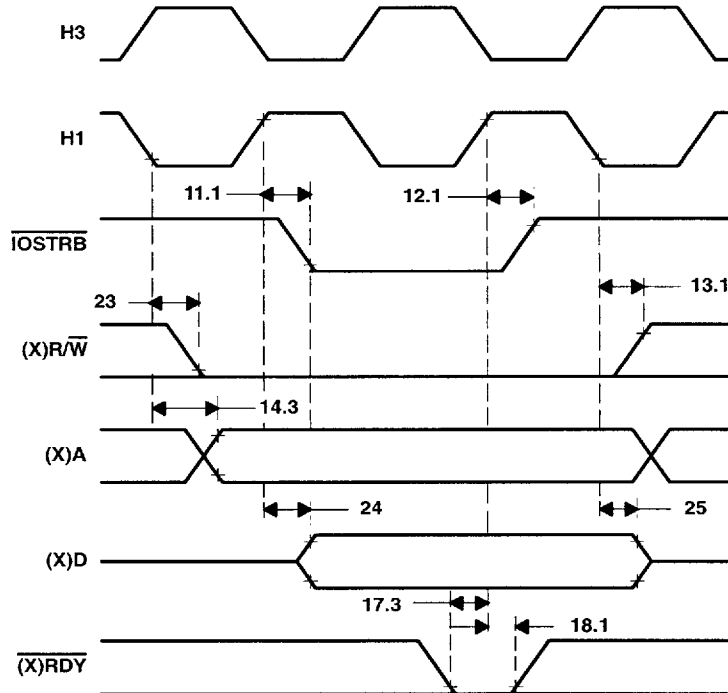


Figure 12. Timing for Memory ($\overline{\text{IOSTRB}} = 0$) Write



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443



**TMS320C30
DIGITAL SIGNAL PROCESSOR**

SPRS032A – APRIL 1996 – REVISED JUNE 1997

XF0 and XF1 timing when executing LDFI or LDII

The following table defines the timing parameters for XF0 and XF1 during execution of LDFI or LDII. The numbers shown in Figure 13 correspond with those in the NO. column of the table below.

timing parameters for XF0 and XF1 when executing LDFI or LDII (see Figure 13)

NO.		'C30-27		'C30-33		'C30-40		'C30-50		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
1	$t_d(H3H-XF0L)$ Delay time, H3 high to XF0 low		19		15		13		12	ns
2	$t_{su}(XF1-H1L)$ Setup time, XF1 before H1 low	13		10		9		9		ns
3	$t_h(H1L-XF1)$ Hold time, XF1 after H1 low	0		0		0		0		ns

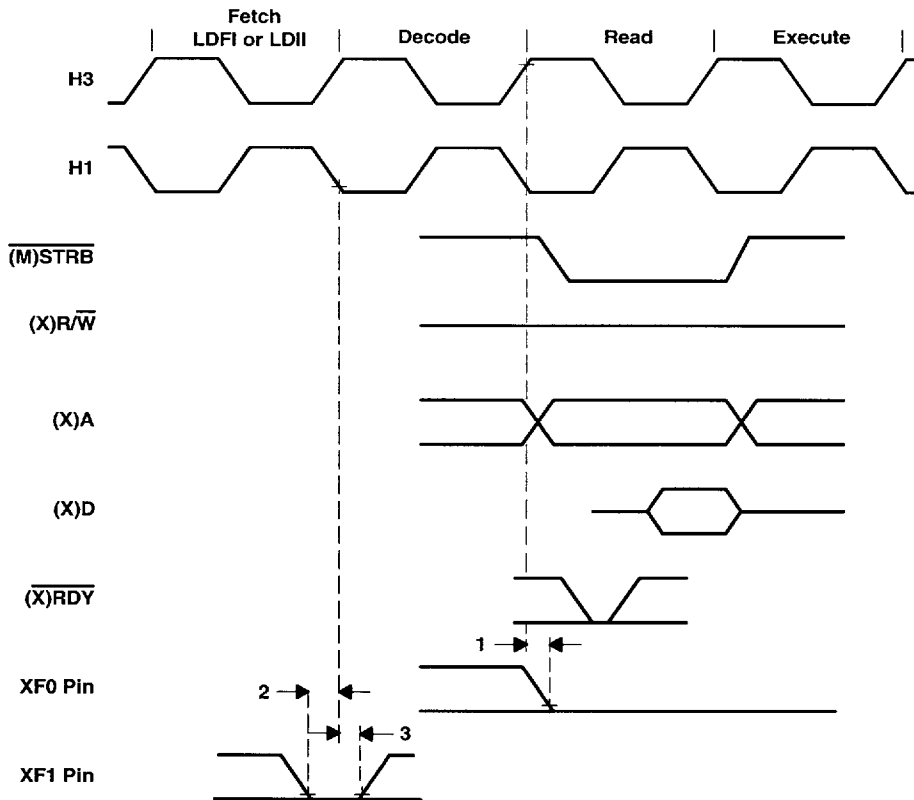


Figure 13. Timing for XF0 and XF1 When Executing LDFI or LDII



XF0 timing when executing STFI and STII

The following table defines the timing parameters for the XF0 pin during execution of STFI or STII. The number shown in Figure 14 corresponds with the number in the NO. column of the table below.

timing parameters for XF0 when executing STFI or STII (see Figure 14)

NO.		'C30-27		'C30-33		'C30-40		'C30-50		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
1	$t_d(H3H-XF0H)$ Delay time, H3 high to XF0 high		19		15		13		12	ns

XF0 is always set high at the beginning of the execute phase of the interlock store instruction. When no pipeline conflicts occur, the address of the store is also driven at the beginning of the execute phase of the interlock store instruction. However, if a pipeline conflict prevents the store from executing, the address of the store will not be driven until the store can execute.

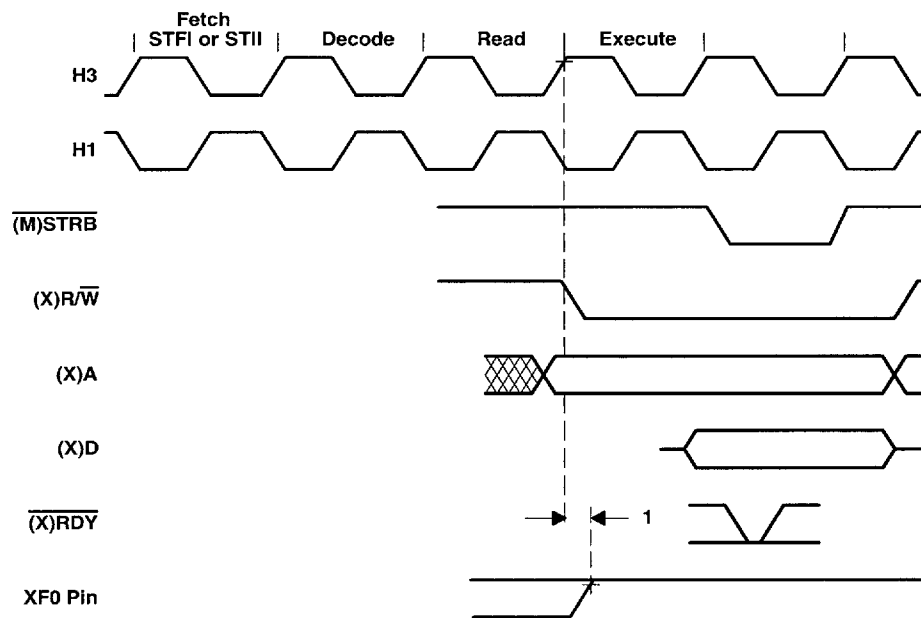


Figure 14. Timing for XF0 When Executing an STFI or STII



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443



TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

XF0 and XF1 timing when executing SIGI

The following table defines the timing parameters for the XF0 and XF1 pins during execution of SIGI. The numbers shown in Figure 15 correspond with those in the NO. column of the table below.

timing parameters for XF0 and XF1 when executing SIGI (see Figure 15)

NO.		'C30-27		'C30-33		'C30-40		'C30-50		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
1	$t_d(H3H-XF0L)$ Delay time, H3 high to XF0 low		19		15		13		12	ns
2	$t_d(H3H-XF0H)$ Delay time, H3 high to XF0 high		19		15		13		12	ns
3	$t_{su}(XF1-H1L)$ Setup time, XF1 before H1 low	13		10		9		9		ns
4	$t_h(H1L-XF1)$ Hold time, XF1 after H1 low	0		0		0		0		ns

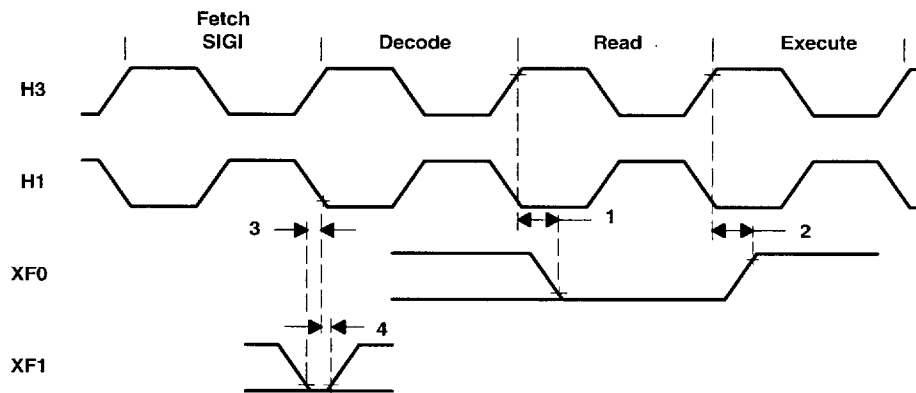


Figure 15. Timing for XF0 and XF1 When Executing SIGI



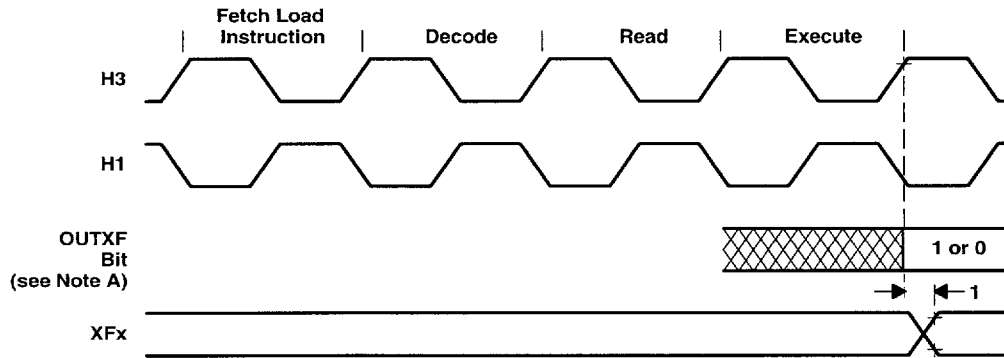
POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

loading when XFx is configured as an output

The following table defines the timing parameter for loading the XF register when the XFx pin is configured as an output. The number shown in Figure 16 corresponds with the number in the NO. column of the table below.

timing parameters for loading the XFx register when configured as an output pin (see Figure 16)

NO.		'C30-27		'C30-33		'C30-40		'C30-50		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
1	$t_{V(H3H-XF)}$ Valid time, H3 high to XFx		19		15		13		12	ns



NOTE A: OUTXFx represents either bit 2 or 6 of the IOF register.

Figure 16. Timing for Loading XFx Register When Configured as an Output Pin



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

■ 8961722 0099395 747 ■

TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

changing XFx from an output to an input

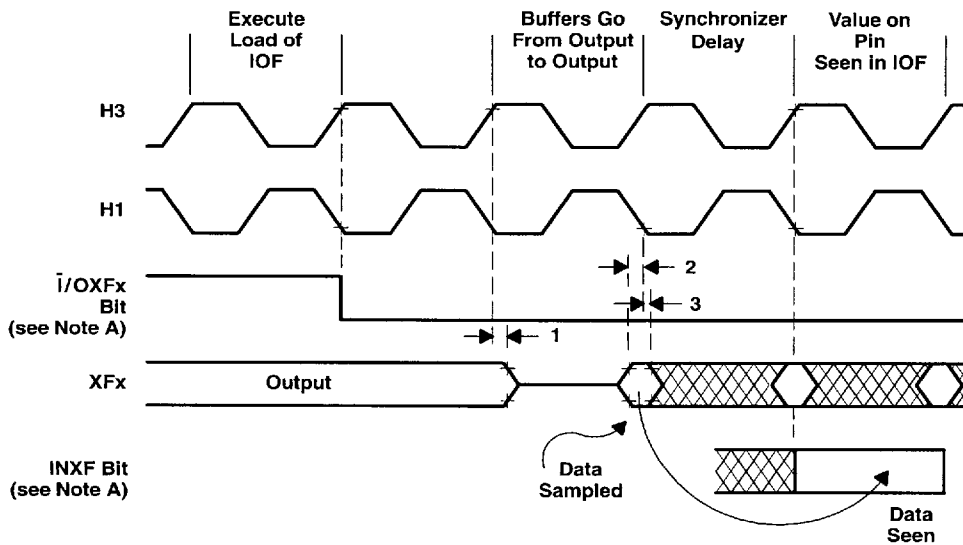
The following table defines the timing parameters for changing the XFx pin from an output pin to an input pin. The numbers shown in Figure 17 correspond with those in the NO. column of the table below.

timing parameters of XFx changing from output to input mode (see Figure 17)

NO.		'C30-27		'C30-33		'C30-40		'C30-50		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
1	$t_h(H3H-XF)$ Hold time, XFx after H3 high		19‡		15‡		13‡†		12‡	ns
2	$t_{su}(XF-H1L)$ Setup time, XFx before H1 low	13		10		9		9		ns
3	$t_h(H1L-XF)$ Hold time, XFx after H1 low	0		0		0		0		ns

† For 'C30 PPM, $t_h(H3H-XF01)$ (max)=14 ns

‡ This value is characterized but not tested



NOTE A: \bar{I}/OXF_x represents bit 1 or 5 of the IOF register, and $INXF_x$ represents either bit 3 or bit 7 of the IOF register.

Figure 17. Timing for Change of XFx From Output to Input Mode



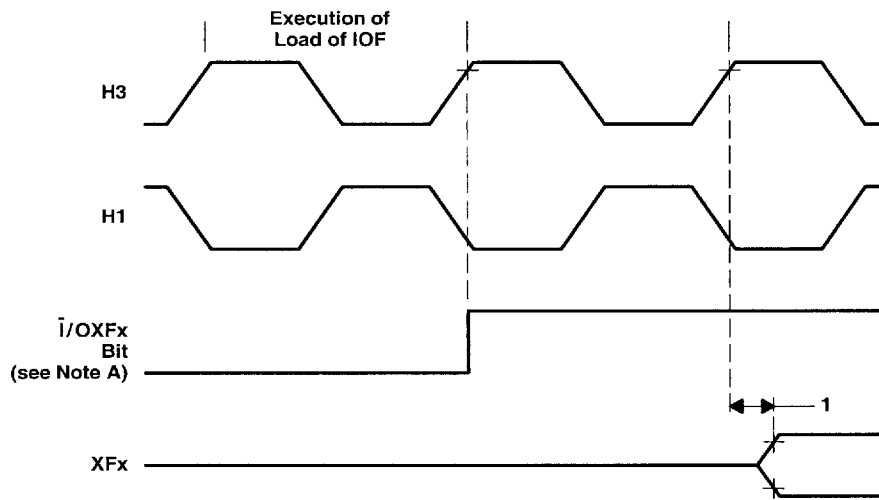
POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

changing XFx from an input to an output

The following table defines the timing parameter for changing the XFx pin from an input pin to an output pin. The number shown in Figure 18 corresponds with the number in the NO. column of the table below.

timing parameters of XFx changing from input to output mode (see Figure 18)

NO.			'C30-27		'C30-33		'C30-40		'C30-50		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
1	$t_d(H3H-XFIO)$	Delay time, H3 high to XFx switching from input to output		25		20		17		17	ns



NOTE A: \bar{I}/OXF_x represents either bit 1 or 5 of the IOF register.

Figure 18. Timing for Change of XFx From Input to Output Mode



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

**TMS320C30
DIGITAL SIGNAL PROCESSOR**

SPRS032A - APRIL 1996 - REVISED JUNE 1997

reset timing

RESET is an asynchronous input that can be asserted at any time during a clock cycle. If the specified timings are met, the exact sequence shown in Figure 19 occurs; otherwise, an additional delay of one clock cycle is possible.

The asynchronous reset signals include XF0/1, CLKX0/1, DX0/1, FSX0/1, CLKR0/1, DR0/1, FSR0/1, and TCLK0/1.

The following table defines the timing parameters for the RESET signal. The numbers shown in Figure 19 correspond with those in the NO. column of the following table.

Resetting the device initializes the primary- and expansion-bus control registers to seven software wait states and therefore results in slow external accesses until these registers are initialized.

Note also that HOLD is an asynchronous input and can be asserted during reset.

timing parameters for RESET for the TMS320C30 (see Figure 19)

NO.		'C30-27		'C30-33		'C30-40		'C30-50		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
1	t _{su} (RESET-CL) Setup time, <u>RESET</u> before CLKIN low	28	P††	10	P††	10	P††	10	P††	ns
2.1	t _d (CIH-H1H) Delay time, CLKIN high to H1 high§‡	2	20	2	14	2	12	2	10	ns
2.2	t _d (CIH-H1L) Delay time, CLKIN high to H1 low§‡	2	20	2	14	2	12	2	10	ns
3	t _{su} (RESETH-H1L) Setup time, <u>RESET</u> high before H1 low and after ten H1 clock cycles	13		10		9		7		ns
5.1	t _d (CIH-H3L) Delay time, CLKIN high to H3 low§‡	2	20	2	14	2	12	2	10	ns
5.2	t _d (CIH-H3H) Delay time, CLKIN high to H3 high§‡	2	20	2	14	2	12	2	10	ns
8	t _{dis} (H1H-(X)D) Disable time, H1 high to (X)D (high impedance)		19†		15†		13†		12†	ns
9	t _{dis} (H3H-(X)A) Disable time, H3 high to (X)A (high impedance)		13†		10†		9†		8†	ns
10	t _d (H3H-CONTROLH) Delay time, H3 high to control signals high		13†		10†		9†		8†	ns
12	t _d (H1H-RWH) Delay time, H1 high to R \overline{W} high		13†		10†		9†		8†	ns
13	t _d (H1H-IACKH) Delay time, H1 high to IACK high		13†		10†		9†		8†	ns
14	t _{dis} (RESETH-ASYNCH) Disable time, <u>RESET</u> low to asynchronous reset signals (high impedance)		31†		25†		21†		17†	ns

† This value is characterized but not tested

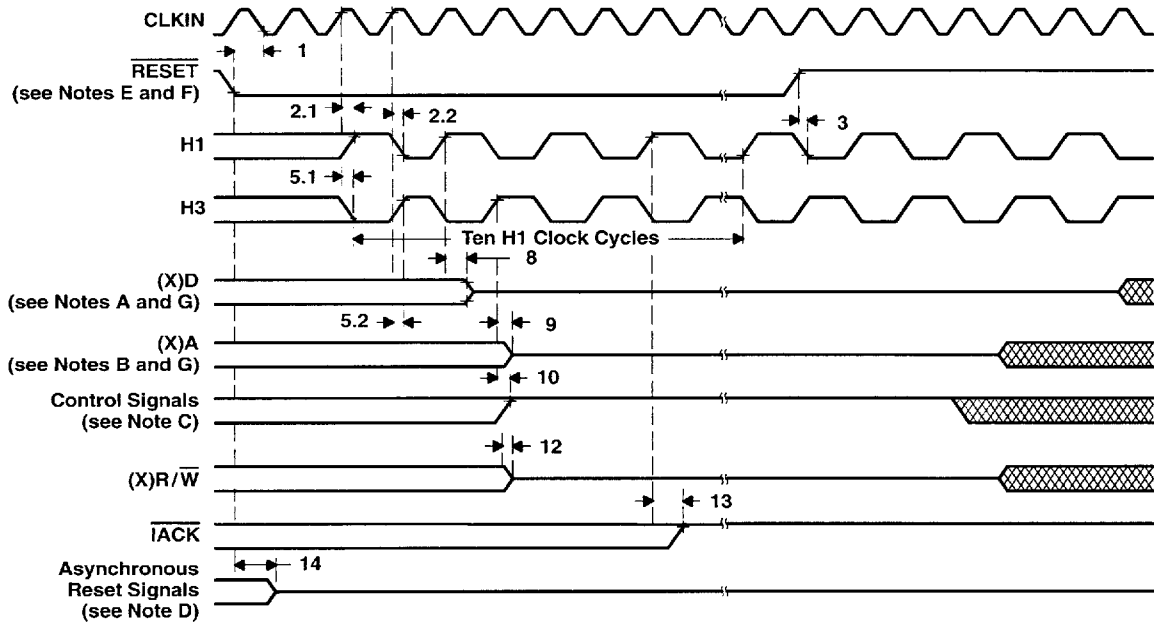
‡ P = t_c(Cl)

§ See Figure 20 for temperature dependence for the 33-MHz and the 40-MHz TMS320C30.

¶ See Figure 21 for temperature dependence for the 50-MHz TMS320C30.



reset timing (continued)



- NOTES: A. (X)D includes D31–D0 and XD31–XD0.
 B. (X)A includes A23–A0 and XA12–XA0.
 C. Interface signals include $\overline{\text{STRB}}$, $\overline{\text{MSTRB}}$, and $\overline{\text{IOSTRB}}$.
 D. Asynchronous reset signals include XF0/1, CLKX0/1, DX0/1, FSX0/1, CLKR0/1, DR0/1, FSR0/1, and TCLK0/1.
 E. $\overline{\text{RESET}}$ is an asynchronous input and can be asserted at any point during a clock cycle. If the specified timings are met, the exact sequence shown occurs; otherwise, an additional delay of one clock cycle is possible.
 F. The R/W and XR/W outputs are placed in a high-impedance state during reset and can be provided with a resistive pullup, nominally 18–22 k Ω , if undesirable spurious writes could be caused when these outputs go low.
 G. In microprocessor mode, the reset vector is fetched twice, with seven software wait states each time. In microcomputer mode, the reset vector is fetched twice, with no software wait states.

Figure 19. Timing for $\overline{\text{RESET}}$



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

reset timing (continued)

Figure 20 and Figure 21 illustrate CLKIN-to-H1 and CLKIN-to-H3 timing as a function of case temperature.

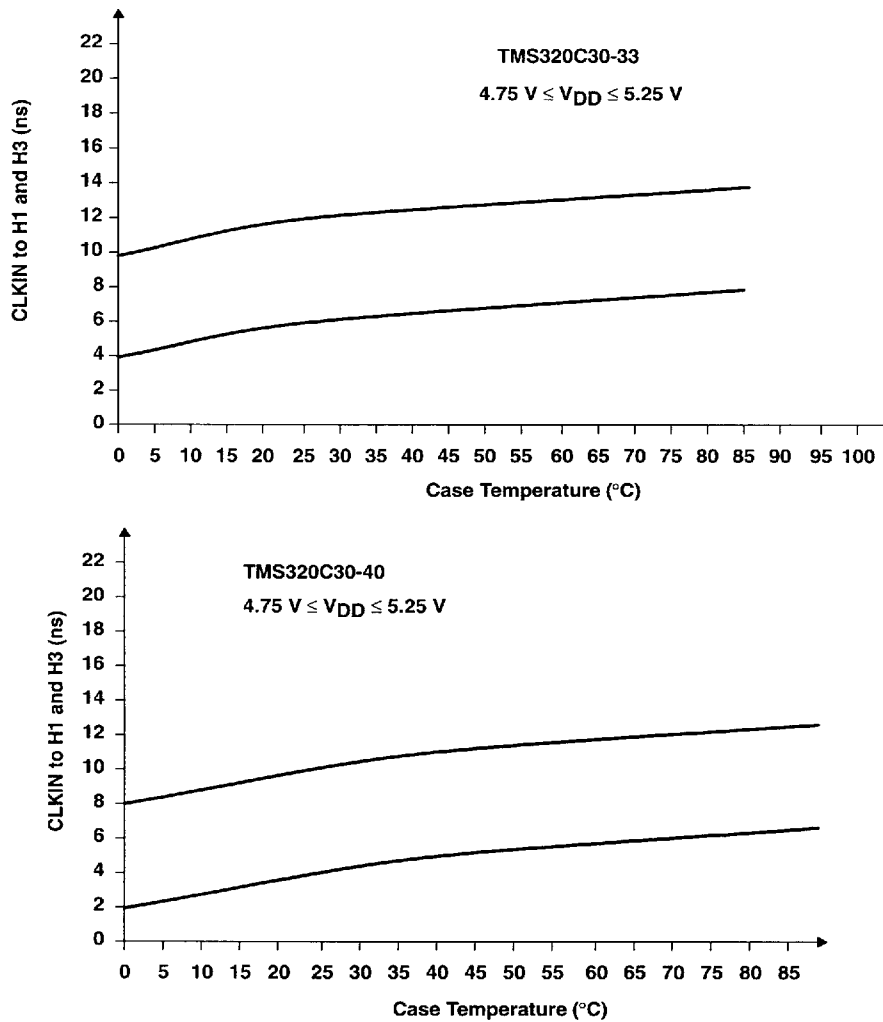


Figure 20. CLKIN to H1 and H3 as a Function of Temperature

reset timing (continued)

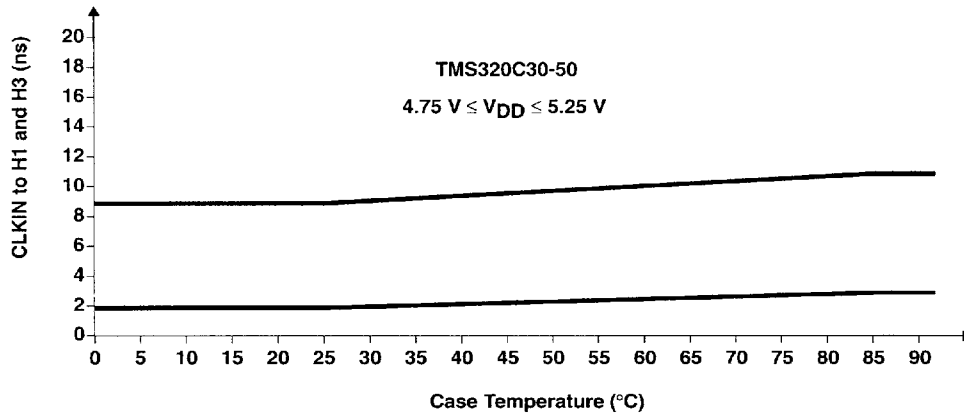


Figure 21. CLKIN to H1 and H3 as a Function of Temperature



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443



TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

interrupt response timing

The following table defines the timing parameters for the $\overline{\text{INT}}$ signals. The numbers shown in Figure 22 correspond with those in the NO. column of the table below.

timing parameters for $\overline{\text{INT3}}-\overline{\text{INT0}}$ (see Figure 22)

NO.		'C30-27		'C30-33		'C30-40		'C30-50		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
1	$t_{su}(\overline{\text{INT}}-\text{H1L})$ Setup time, $\overline{\text{INT3}}-\overline{\text{INT0}}$ before H1 low	19		15		13		10		ns
2	$t_w(\overline{\text{INT}})$ Pulse duration, interrupt to ensure only one interrupt	P	$2P\ddagger$	P	$2P\ddagger$	P	$2P\ddagger$	P	$2P\ddagger$	ns

† Characterized but not tested

‡ $P = t_c(H)$

The interrupt ($\overline{\text{INT}}$) pins are asynchronous inputs that can be asserted at any time during a clock cycle. The TMS320C30 interrupts are level-sensitive, not edge-sensitive. Interrupts are detected on the falling edge of H1. Therefore, interrupts must be set up and held to the falling edge of H1 for proper detection. The CPU and DMA respond to detected interrupts on instruction-fetch boundaries only.

For the processor to recognize only one interrupt on a given input, an interrupt pulse must be set up and held to:

- A minimum of one H1 falling edge
- No more than two H1 falling edges

The TMS320C30 can accept an interrupt from the same source every two H1 clock cycles.

If the specified timings are met, the exact sequence shown in Figure 22 occurs; otherwise, an additional delay of one clock cycle is possible.

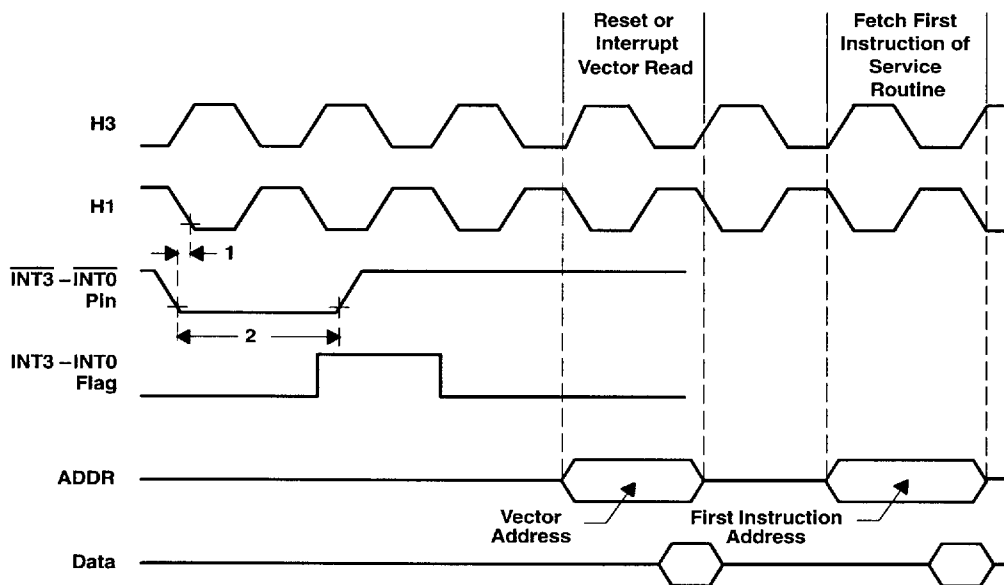


Figure 22. Timing for $\overline{\text{INT3}}-\overline{\text{INT0}}$ Response



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

interrupt-acknowledge timing

The $\overline{\text{IACK}}$ output goes active on the first half-cycle (H1 rising) of the decode phase of the IACK instruction and goes inactive at the first half-cycle (H1 rising) of the read phase of the IACK instruction.

The following table defines the timing parameters for the $\overline{\text{IACK}}$ signal. The numbers shown in Figure 23 correspond with those in the NO. column of the table below.

timing parameters for $\overline{\text{IACK}}$ (see Note 6 and Figure 23)

NO.		'C30-27		'C30-33		'C30-40		'C30-50		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
1	$t_{d(H1H-IACKL)}$ Delay time, H1 high to $\overline{\text{IACK}}$ low		13		10		9		7	ns
2	$t_{d(H1H-IACKH)}$ Delay time, H1 high to $\overline{\text{IACK}}$ high		13		10		9		7	ns

NOTE 6: $\overline{\text{IACK}}$ goes active on the first half-cycle (H1 rising) of the decode phase of the IACK instruction and goes inactive at the first half-cycle (H1 rising) of the read phase of the IACK instruction. Because of the pipeline conflicts, $\overline{\text{IACK}}$ remains low for one cycle even if the decode phase of the IACK instruction is extended.

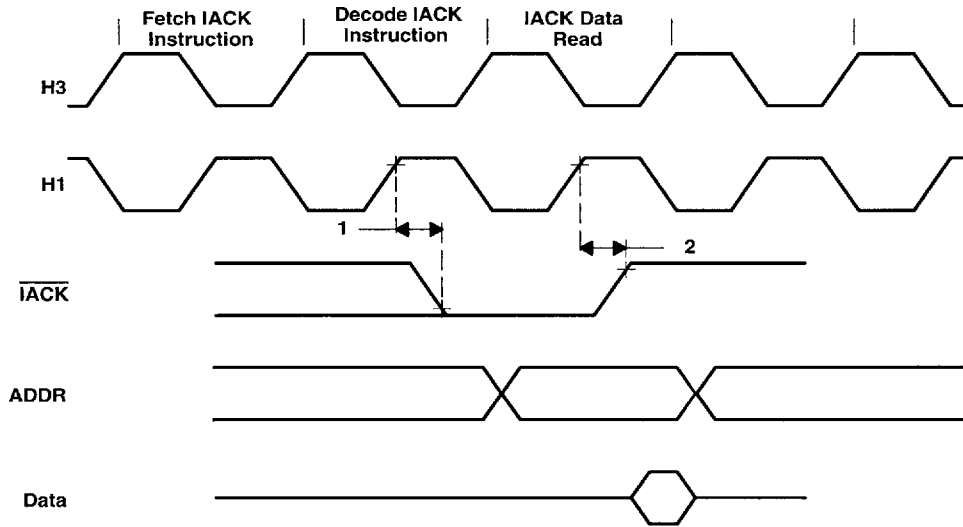


Figure 23. Timing for $\overline{\text{IACK}}$



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

8961722 0099403 643

TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

serial-port timing parameters (see Figure 24 and Figure 25)

NO.			'320C30-27		UNIT	
			MIN	MAX		
1	$t_d(H1H-SCK)$	Delay time, H1 high to internal CLKX/R	19		ns	
2	$t_c(SCK)$	Cycle time, CLKX/R	CLKX/R ext	$t_c(H) \times 2.6$	ns	
			CLKX/R int	$t_c(H) \times 2$		$t_c(H) \times 2^{32}$
3	$t_w(SCK)$	Pulse duration, CLKX/R high/low	CLKX/R ext	$t_c(H) + 12$	ns	
			CLKX/R int	$[t_c(SCK)/2] - 15$		$[t_c(SCK)/2] + 5$
4	$t_r(SCK)$	Rise time, CLKX/R	10		ns	
5	$t_f(SCK)$	Fall time, CLKX/R	10		ns	
6	$t_d(CH-DX)$	Delay time, CLKX to DX valid	CLKX ext	44	ns	
			CLKX int	25		
7	$t_{su}(DR-CLKRL)$	Setup time, DR before CLKR low	CLKR ext	13	ns	
			CLKR int	31		
8	$t_h(CLKRL-DR)$	Hold time, DR from CLKR low	CLKR ext	13	ns	
			CLKR int	0		
9	$t_d(CH-FSX)$	Delay time, CLKX to internal FSX high/low	CLKX ext	40	ns	
			CLKX int	21		
10	$t_{su}(FSR-CLKRL)$	Setup time, FSR0 or FSR1 before CLKR low	CLKR ext	13	ns	
			CLKR int	13		
11	$t_h(SCKL-FS)$	Hold time, FSX/R input from CLKX/R low	CLKX/R ext	13	ns	
			CLKX/R int	0		
12	$t_{su}(FSX-CH)$	Setup time, external FSX before CLKX	CLKX ext	$-[t_c(H) - 8]^\dagger$	$[t_c(SCK)/2] - 10^\dagger$	ns
			CLKX int	$-[t_c(H) - 21]^\dagger$	$t_c(SCK)/2^\dagger$	
13	$t_d(CH-DX)V$	Delay time, CLKX to first DX bit, FSX0 or FSX1 precedes CLKX high	CLKX ext	45 [†]	ns	
			CLKX int	26 [†]		
14	$t_d(FSX-DX)V$	Delay time, FSX0 or FSX1 to first DX bit, CLKX precedes FSX0 or FSX1	45 [†]		ns	
15	$t_d(CHH-DXZ)$	Delay time, CLKX high to DX high impedance following last data bit	25 [†]		ns	

[†] This value is characterized but not tested



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

serial-port timing parameters (see Figure 24 and Figure 25) (continued)

NO.			'320C30-33		UNIT	
			MIN	MAX		
1	$t_d(H1H-SCK)$	Delay time, H1 high to internal CLKX/R	15		ns	
2	$t_c(SCK)$	Cycle time, CLKX/R	CLKX/R ext	$t_c(H) \times 2.6$	ns	
			CLKX/R int	$t_c(H) \times 2$		$t_c(H) \times 2^{32}$
3	$t_w(SCK)$	Pulse duration, CLKX/R high/low	CLKX/R ext	$t_c(H) + 12$	ns	
			CLKX/R int	$[t_c(SCK)/2] - 15$		$[t_c(SCK)/2] + 5$
4	$t_r(SCK)$	Rise time, CLKX/R	8		ns	
5	$t_f(SCK)$	Fall time, CLKX/R	8		ns	
6	$t_d(CH-DX)$	Delay time, CLKX to DX valid	CLKX ext	35	ns	
			CLKX int	20		
7	$t_{su}(DR-CLKRL)$	Setup time, DR before CLKR low	CLKR ext	10	ns	
			CLKR int	25		
8	$t_h(CLKRL-DR)$	Hold time, DR from CLKR low	CLKR ext	10	ns	
			CLKR int	0		
9	$t_d(CH-FSX)$	Delay time, CLKX to internal FSX high/low	CLKX ext	32	ns	
			CLKX int	17		
10	$t_{su}(FSR-CLKRL)$	Setup time, FSR before CLKR low	CLKR ext	10	ns	
			CLKR int	10		
11	$t_h(SCKL-FS)$	Hold time, FSX/R input from CLKX/R low	CLKX/R ext	10	ns	
			CLKX/R int	0		
12	$t_{su}(FSX-CH)$	Setup time, external FSX before CLKX	CLKX ext	$-[t_c(H) - 8]^\dagger$	$[t_c(SCK)/2] - 10^\dagger$	ns
			CLKX int	$[t_c(H) - 21]^\dagger$	$t_c(SCK)/2^\dagger$	
13	$t_d(CH-DX)V$	Delay time, CLKX to first DX bit, FSX precedes CLKX high	CLKX ext	36^\dagger	ns	
			CLKX int	21^\dagger		
14	$t_d(FSX-DX)V$	Delay time, FSX to first DX bit, CLKX precedes FSX	36^\dagger		ns	
15	$t_d(CHH-DXZ)$	Delay time, CLKX high to DX high impedance following last data bit	20^\dagger		ns	

† This value is characterized but not tested



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

■ 8961722 0099405 416 ■

TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

serial-port timing parameters (see Figure 24 and Figure 25) (continued)

NO.			'320C30-40		UNIT
			MIN	MAX	
1	$t_d(H1H-SCK)$	Delay time, H1 high to internal CLKX/R	13		ns
2	$t_c(SCK)$	Cycle time, CLKX/R	CLKX/R ext	$t_c(H) \times 2.6$	ns
			CLKX/R int	$t_c(H) \times 2$	
3	$t_w(SCK)$	Pulse duration, CLKX/R high/low	CLKX/R ext	$t_c(H) + 10$	ns
			CLKX/R int	$[t_c(SCK)/2] - 5$	
4	$t_r(SCK)$	Rise time, CLKX/R	7		ns
5	$t_f(SCK)$	Fall time, CLKX/R	7		ns
6	$t_d(CH-DX)$	Delay time, CLKX to DX valid	CLKX ext	30	ns
			CLKX int	17	
7	$t_{su}(DR-CLKRL)$	Setup time, DR before CLKR low	CLKR ext	9	ns
			CLKR int	21	
8	$t_h(CLKRL-DR)$	Hold time, DR from CLKR low	CLKR ext	9	ns
			CLKR int	0	
9	$t_d(CH-FSX)$	Delay time, CLKX to internal FSX high/low	CLKX ext	27	ns
			CLKX int	15	
10	$t_{su}(FSR-CLKRL)$	Setup time, FSR before CLKR low	CLKR ext	9	ns
			CLKR int	9	
11	$t_h(SCKL-FS)$	Hold time, FSX/R input from CLKX/R low	CLKX/R ext	9	ns
			CLKX/R int	0	
12	$t_{su}(FSX-CH)$	Setup time, external FSX before CLKX	CLKX ext	$-[t_c(H) - 8]^\dagger$	ns
			CLKX int	$[t_c(H) - 21]^\dagger$	
13	$t_d(CH-DX)V$	Delay time, CLKX to first DX bit, FSX precedes CLKX high	CLKX ext	30^\dagger	ns
			CLKX int	18^\dagger	
14	$t_d(FSX-DX)V$	Delay time, FSX to first DX bit, CLKX precedes FSX	30^\dagger		ns
15	$t_d(CHH-DXZ)$	Delay time, CLKX high to DX high impedance following last data bit	17^\dagger		ns

† This value is characterized but not tested



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

serial-port timing parameters (see Figure 24 and Figure 25) (continued)

NO.			'320C30-50		UNIT	
			MIN	MAX		
1	$t_d(H1H-SCK)$	Delay time, H1 high to internal CLKX/R		10	ns	
2	$t_c(SCK)$	Cycle time, CLKX/R	CLKX/R ext CLKX/R int	$t_{c(H)} \times 2.6$ $t_{c(H)} \times 2$	$t_{c(H)} \times 2^{32}$	ns
3	$t_w(SCK)$	Pulse duration, CLKX/R high/low	CLKX/R ext CLKX/R int	$t_{c(H)} + 10$ $[t_{c(SCK)/2}] - 5$	$[t_{c(SCK)/2}] + 5$	ns
4	$t_r(SCK)$	Rise time, CLKX/R		6		ns
5	$t_f(SCK)$	Fall time, CLKX/R		6		ns
6	$t_d(CH-DX)$	Delay time, CLKX to DX valid	CLKX ext CLKX int	24 16		ns
7	$t_{su}(DR-CLKRL)$	Setup time, DR before CLKR low	CLKR ext CLKR int	9 17		ns
8	$t_h(CLKRL-DR)$	Hold time, DR from CLKR low	CLKR ext CLKR int	7 0		ns
9	$t_d(CH-FSX)$	Delay time, CLKX to internal FSX high/low	CLKX ext CLKX int	22 15		ns
10	$t_{su}(FSR-CLKRL)$	Setup time, FSR before CLKR low	CLKR ext CLKR int	7 7		ns
11	$t_h(SCKL-FS)$	Hold time, FSX/R input from CLKX/R low	CLKX/R ext CLKX/R int	7 0		ns
12	$t_{su}(FSX-CH)$	Setup time, external FSX before CLKX	CLKX ext CLKX int	$-[t_{c(H)} - 8]^\dagger$ $[t_{c(H)} - 21]^\dagger$	$[t_{c(SCK)/2}] - 10^\dagger$ $t_{c(SCK)/2}^\dagger$	ns
13	$t_d(CH-DX)V$	Delay time, CLKX to first DX bit, FSX precedes CLKX high	CLKX ext CLKX int	24 † 14 †		ns
14	$t_d(FSX-DX)V$	Delay time, FSX to first DX bit, CLKX precedes FSX		24 †		ns
15	$t_d(CHH-DXZ)$	Delay time, CLKX high to DX high impedance following last data bit		14 †		ns

† This value is characterized but not tested



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

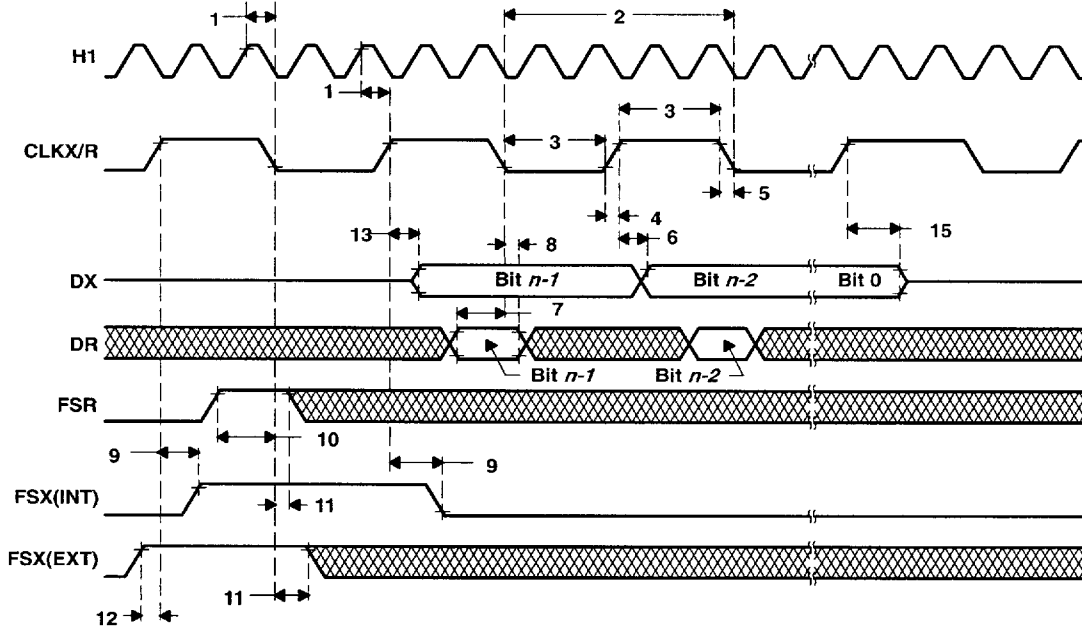
8961722 0099407 299

TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

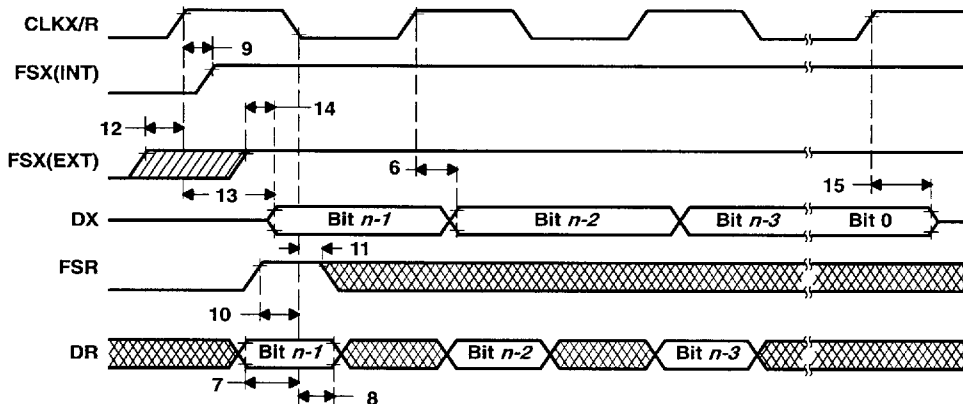
data-rate timing modes

Unless otherwise indicated, the data-rate timings shown in Figure 24 and Figure 25 are valid for all serial-port modes, including handshake. See serial-port timing parameter tables.



- NOTES: A. Timing diagrams show operations with $CLKXP = CLKRP = FSXP = FSRP = 0$.
B. Timing diagrams depend on the length of the serial port word, where $n = 8, 16, 24,$ or 32 bits, respectively.

Figure 24. Timing for Fixed Data-Rate Mode



- NOTES: A. Timing diagrams show operation with $CLKXP = CLKRP = FSXP = FSRP = 0$.
B. Timing diagrams depend on the length of the serial-port word, where $n = 8, 16, 24,$ or 32 bits, respectively.
C. The timings that are not specified expressly for the variable data-rate mode are the same as those that are specified for the fixed data-rate mode.

Figure 25. Timing for Variable Data-Rate Mode

HOLD timing

$\overline{\text{HOLD}}$ is an asynchronous input that can be asserted at any time during a clock cycle. If the specified timings are met, the exact sequence shown in Figure 26 occurs; otherwise, an additional delay of one clock cycle is possible.

The “timing parameters for $\overline{\text{HOLD}}/\overline{\text{HOLDA}}$ ” table defines the timing parameters for the $\overline{\text{HOLD}}$ and $\overline{\text{HOLDA}}$ signals. The numbers shown in Figure 26 correspond with those in the NO. column of the table.

The NOHOLD bit of the primary bus control register overrides the $\overline{\text{HOLD}}$ signal. When this bit is set, the device comes out of hold and prevents future hold cycles.

Asserting $\overline{\text{HOLD}}$ prevents the processor from accessing the primary bus. Program execution continues until a read from or a write to the primary bus is requested. In certain circumstances, the first write is pending, thus allowing the processor to continue until a second write is encountered.



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443



**TMS320C30
DIGITAL SIGNAL PROCESSOR**

SPRS032A - APRIL 1996 - REVISED JUNE 1997

HOLD timing (continued)

timing parameters for HOLD/HOLDA (see Figure 26)

NO.	Description	'C30-27		'C30-33		'C30-40		'C30-50		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
1	t_{su} (HOLD-H1L) Setup time, HOLD before H1 low	19		15		13		10		ns
3	t_{v} (H1L-HOLDA) Valid time, HOLDA after H1 low	0†	14	0†	10	0†	9	0†	7	ns
4	t_w (HOLD†) Pulse duration, HOLD low		$2t_c$ (H)		$2t_c$ (H)		$2t_c$ (H)		$2t_c$ (H)	ns
6	t_w (HOLDA) Pulse duration, HOLDA low		t_c (H)-5†		t_c (H)-5†		t_c (H)-5†		t_c (H)-5†	ns
7	t_d (H1L-SH)HOLD Delay time, H1 low to (M)S and IOS high for a HOLD	0§	13	0§	10	0§	9	0§	7	ns
8	t_{dis} (H1L-S)Z Disable time, H1 low to (M)S and IOS in the high-impedance state	0§	13†	0§	10†	0§	9†	0§	8†	ns
9	t_{en} (H1L-S) Enable time, H1 low to (M)S and IOS (active)	0§	13	0§	10	0§	9	0§	7	ns
10	t_{dis} (H1L-(X)RW)Z Disable time, H1 low to (X)R \bar{W} in the high-impedance state	0†	13†	0†	10†	0†	9†	0†	8†	ns
11	t_{en} (H1L-(X)RW) Enable time, H1 low to (X)R \bar{W} (active)	0†	13	0†	10	0†	9	0†	7	ns
12	t_{dis} (H1L-(X)A) Disable time, H1 low to (X)A in the high-impedance state	0§	13†	0§	10†	0§	10†	0§	8†	ns
13	t_{en} (H1L-(X)A) Enable time, H1 low to (X)A (valid)	0§	19	0§	15	0§	13	0§	12	ns
16	t_{dis} (H1H-(X)D)Z Disable time, H1 high to (X)D in the high-impedance state	0§	13†	0§	10†	0§	9†	0§	8†	ns

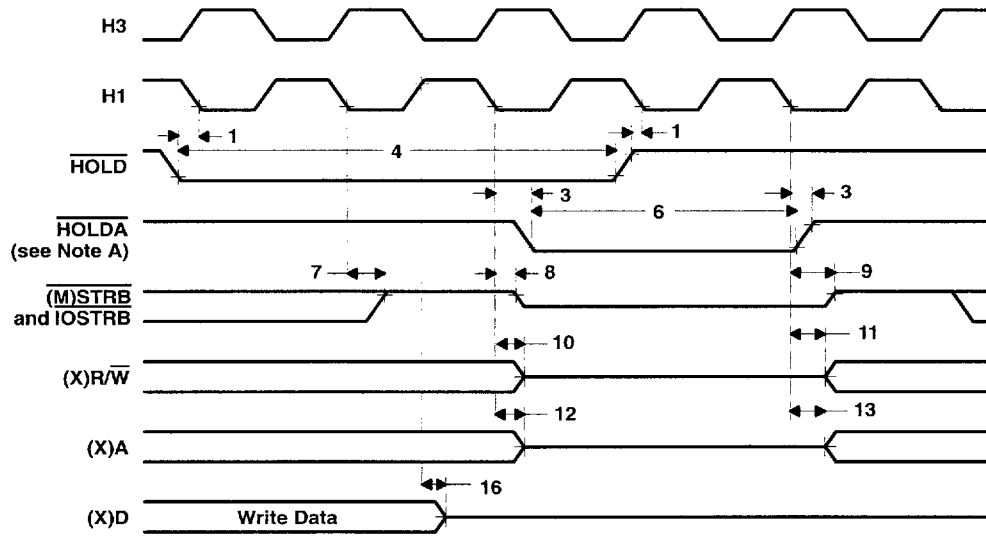
† This value is characterized but not tested

‡ HOLD is an asynchronous input and can be asserted at any point during a clock cycle. If the specified timings are met, the exact sequence shown occurs; otherwise, an additional delay of one clock cycle is possible.

§ Not tested



HOLD timing (continued)



NOTE A: $\overline{\text{HOLDA}}$ goes low in response to $\overline{\text{HOLD}}$ going low and continues to remain low until one H1 cycle after $\overline{\text{HOLD}}$ goes back high.

Figure 26. Timing for $\overline{\text{HOLD}}/\overline{\text{HOLDA}}$



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

8961722 0099411 71T

TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

general-purpose I/O timing

Peripheral pins include CLKX0/1, CLKR0/1, DX0/1, DR0/1, FSX0/1, FSR0/1, and TCLK0/1. The contents of the internal-control registers associated with each peripheral define the modes for these pins.

peripheral pin I/O timing

The following table defines peripheral pin general-purpose I/O timing parameters. The numbers shown in Figure 27 correspond with those in the NO. column of the table below.

timing parameters for peripheral pin general-purpose I/O (see Note 7 and Figure 27)

NO.		'C30-27		'C30-33		'C30-40		'C30-50		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
1	$t_{su}(GPIO-H1L)$ Setup time, general-purpose input before H1 low	15		12		10		9		ns
2	$t_h(H1L-GPIO)$ Hold time, general-purpose input after H1 low	0		0		0		0		ns
3	$t_d(H1H-GPIO)$ Delay time, general-purpose output after H1 high		19		15		13		10	ns

NOTE 7: Peripheral pins include CLKX0/1, CLKR0/1, DX0/1, DR0/1, FSX0/1, FSR0/1, and TCLK0/1. The modes of these pins are defined by the contents of internal control registers associated with each peripheral.

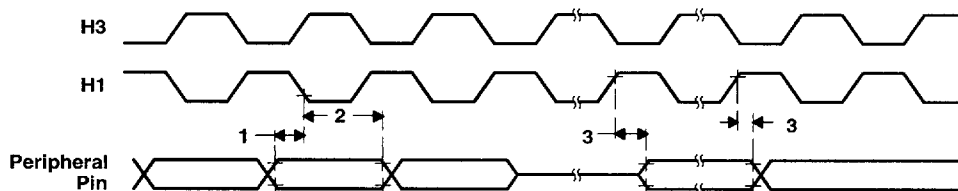


Figure 27. Timing for Peripheral Pin General-Purpose I/O

changing the peripheral pin I/O modes

The following tables show the timing parameters for changing the peripheral pin from a general-purpose output pin to a general-purpose input pin and the reverse. The numbers shown in Figure 28 and Figure 29 correspond to those shown in the NO. column of the following tables.

timing parameters for peripheral pin changing from general-purpose output to input mode (see Note 7 and Figure 28)

NO.		'C30-27		'C30-33		'C30-40		'C30-50		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
1	$t_{h(H1H-GPIO)}$ Hold time, peripheral pin after H1 high		19		15		13		10	ns
2	$t_{su(GPIO-H1L)}$ Setup time, peripheral pin before H1 low	13		10		9		9		ns
3	$t_{h(H1L-GPIO)}$ Hold time, peripheral pin after H1 low	0		0		0		0		ns

NOTE 7: Peripheral pins include CLKX0/1, CLKR0/1, DX0/1, DR0/1, FSX0/1, FSR0/1, and TCLK0/1. The modes of these pins are defined by the contents of internal control registers associated with each peripheral.

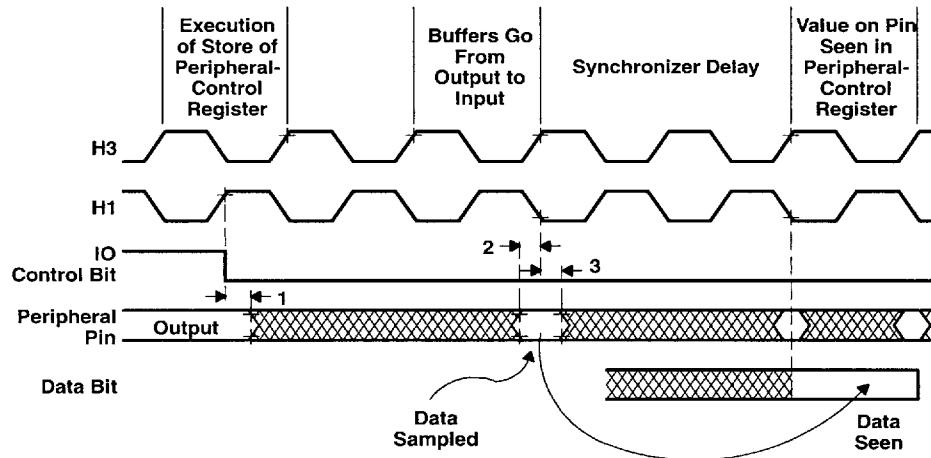


Figure 28. Timing for Change of Peripheral Pin From General-Purpose Output to Input Mode



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

8961722 0099413 592

**TMS320C30
DIGITAL SIGNAL PROCESSOR**

SPRS032A – APRIL 1996 – REVISED JUNE 1997

timing parameters for peripheral pin changing from general-purpose input to output mode (see Note 7 and Figure 29)

NO.		'C30-27		'C30-33		'C30-40		'C30-50		UNIT
		MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
1	$t_{d(H1H-GPIO)}$ Delay time, H1 high to peripheral pin switching from input to output		19		15		13		10	ns

NOTE 7: Peripheral pins include CLKX0/1, CLKR0/1, DX0/1, DR0/1, FSX0/1, FSR0/1, and TCLK0/1. The modes of these pins are defined by the contents of internal-control registers associated with each peripheral.

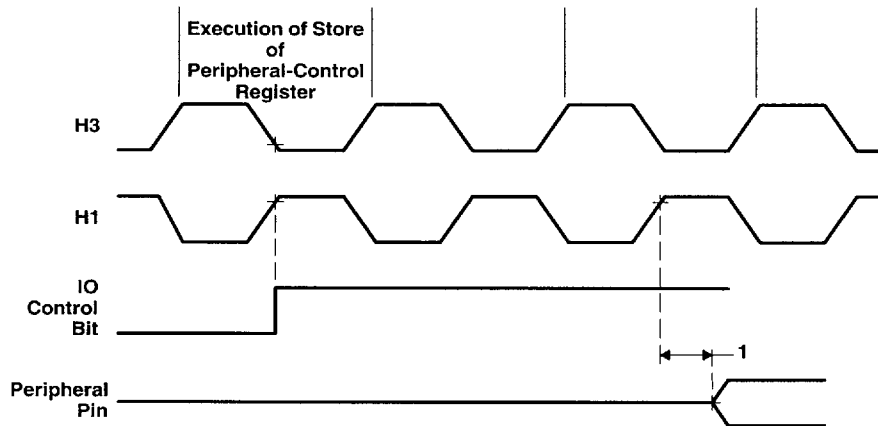


Figure 29. Timing for Change of Peripheral Pin From General-Purpose Input to Output Mode

timer pin (TCLK0 and TCLK1) timing

Valid logic-level periods and polarity are specified by the contents of the internal control registers.

The following tables define the timing parameters for the timer pin. The numbers shown in Figure 30 correspond with those in the NO. column of the tables below.

timing parameters for timer pin (TCLK0 and TCLK1) (see Figure 30)†

NO.		'C30-27†		'C30-33†		UNIT
		MIN	MAX	MIN	MAX	
1	$t_{su}(TCLK-H1L)$ Setup time, TCLK ext before H1 low	15		12		ns
2	$t_h(H1L-TCLK)$ Hold time, TCLK ext after H1 low	0		0		ns
3	$t_d(H1H-TCLK)$ Delay time, H1 high to TCLK int valid		13		10	ns
4	Cycle time, TCLK	$t_c(TCLK)$	$t_c(H) \times 2.6$	$t_c(H) \times 2.6$		ns
		$t_c(TCLK)$	$t_c(H) \times 2$	$t_c(H) \times 2$	$t_c(H) \times 2.32 \ddagger$	
5	Pulse duration, TCLK high/low	$t_w(TCLK)$	$t_c(H) + 12$	$t_c(H) + 12$		ns
		$t_w(TCLK)$	$\lceil t_c(TCLK) / 2 \rceil - 15$	$\lceil t_c(TCLK) / 2 \rceil - 15$	$\lceil t_c(TCLK) / 2 \rceil + 5$	

NO.		'C30-40†		'C30-50†		UNIT
		MIN	MAX	MIN	MAX	
1	$t_{su}(TCLK-H1L)$ Setup time, TCLK ext before H1 low	10		8		ns
2	$t_h(H1L-TCLK)$ Hold time, TCLK ext after H1 low	0		0		ns
3	$t_d(H1H-TCLK)$ Delay time, H1 high to TCLK int valid		9		9	ns
4	Cycle time, TCLK	$t_c(TCLK)$	$t_c(H) \times 2.6$	$t_c(H) \times 2.6$		ns
		$t_c(TCLK)$	$t_c(H) \times 2$	$t_c(H) \times 2$	$t_c(H) \times 2.32 \ddagger$	
5	Pulse duration, TCLK high/low	$t_w(TCLK)$	$t_c(H) + 10$	$t_c(H) + 10$		ns
		$t_w(TCLK)$	$\lceil t_c(TCLK) / 2 \rceil - 5$	$\lceil t_c(TCLK) / 2 \rceil - 5$	$\lceil t_c(TCLK) / 2 \rceil + 5$	

† Timing parameters 1 and 2 are applicable for a synchronous input clock. Timing parameters 4 and 5 are applicable for an asynchronous input clock.

‡ Assured by design but not tested



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443

8961722 0099415 365

TMS320C30 DIGITAL SIGNAL PROCESSOR

SPRS032A – APRIL 1996 – REVISED JUNE 1997

timer pin (TCLK0 and TCLK1) timing (continued)

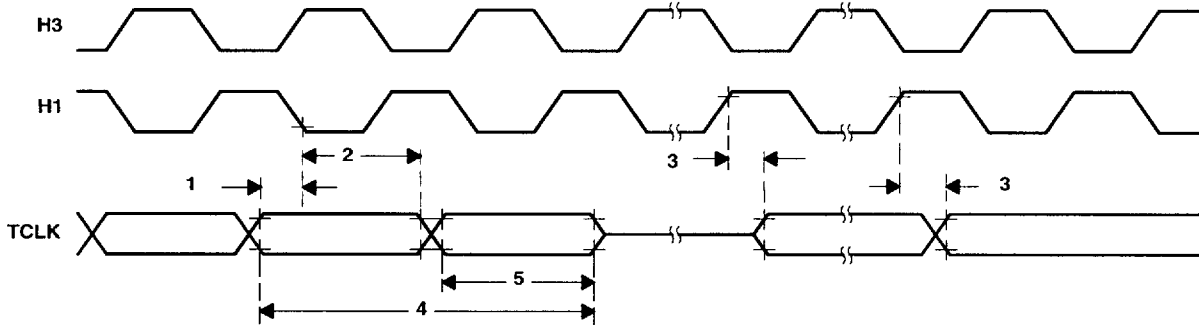


Figure 30. Timing for Timer Pin

SHZ pin timing

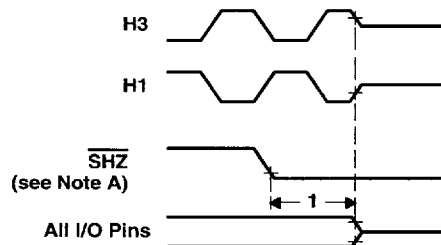
The following table defines the timing parameter for the $\overline{\text{SHZ}}$ pin. The number shown in Figure 31 corresponds with that in the NO. column of the table below.

timing parameters for $\overline{\text{SHZ}}$ pin (see Figure 31)

NO.		'C30		UNIT
		MIN	MAX	
1	$t_{\text{dis}}(\overline{\text{SHZ}})$ Disable time, $\overline{\text{SHZ}}$ low to all outputs, I/O pins disabled (high impedance)	0†	$2P†‡$	ns

† Characterized but not tested

‡ $P = t_c(\text{CI})$



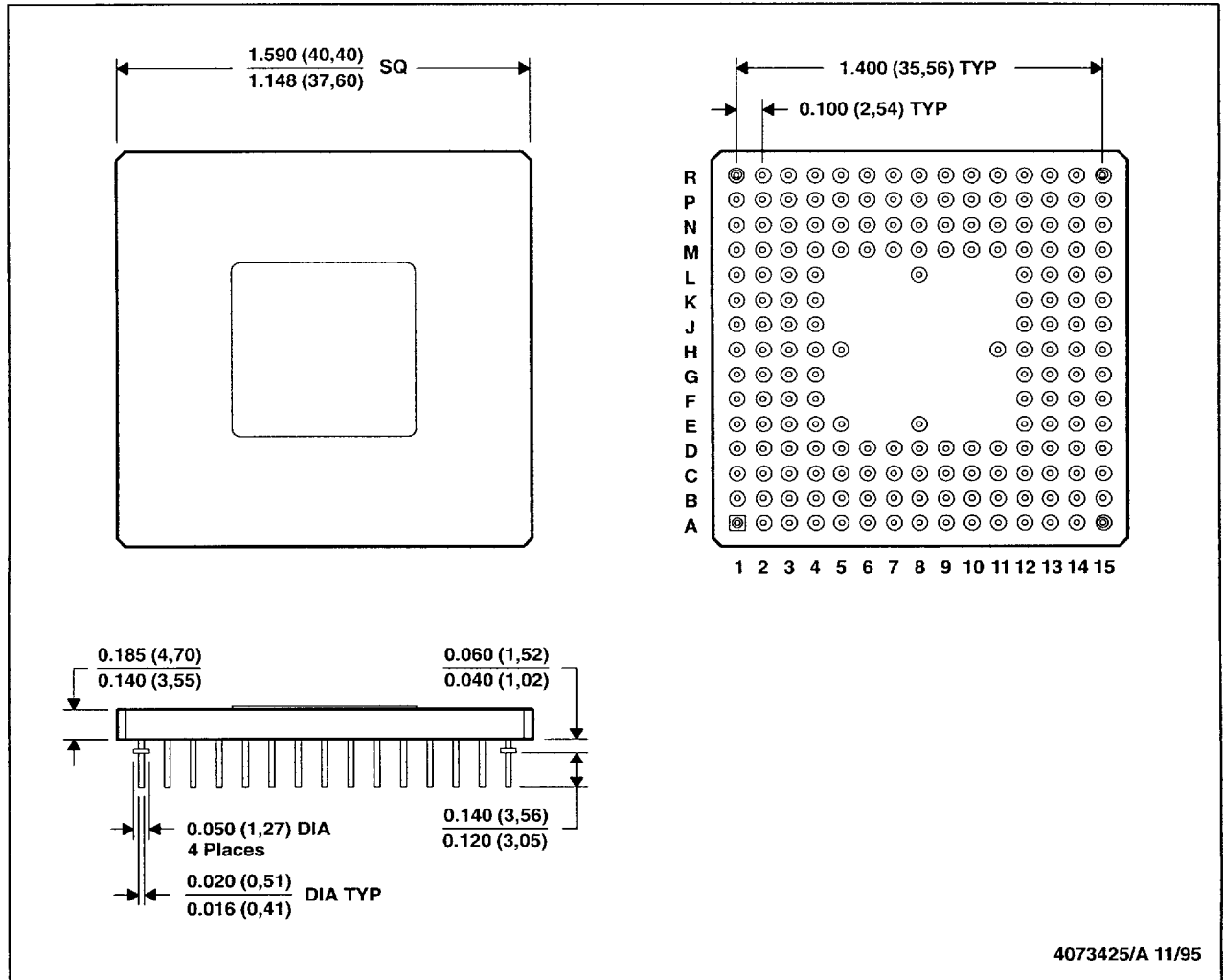
NOTE A: Enabling $\overline{\text{SHZ}}$ destroys TMS320C30 register and memory contents. Assert $\overline{\text{SHZ}} = 1$ and reset the TMS320C30 to restore it to a known condition.

Figure 31. Timing for $\overline{\text{SHZ}}$

MECHANICAL DATA

GE (S-CPGA-P181)

CERAMIC PIN GRID ARRAY PACKAGE



4073425/A 11/95

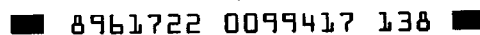
- NOTES: A. All linear dimensions are in inches (millimeters).
B. This drawing is subject to change without notice.

Table 1. Thermal Resistance Characteristics for TMS320C30 GEL (PGA Package)

PARAMETER		MAX	UNIT
R _{θJA}	Junction-to-free air	21.8	°C/W
R _{θJC}	Junction-to-case	2.0	°C/W



POST OFFICE BOX 1443 • HOUSTON, TEXAS 77251-1443



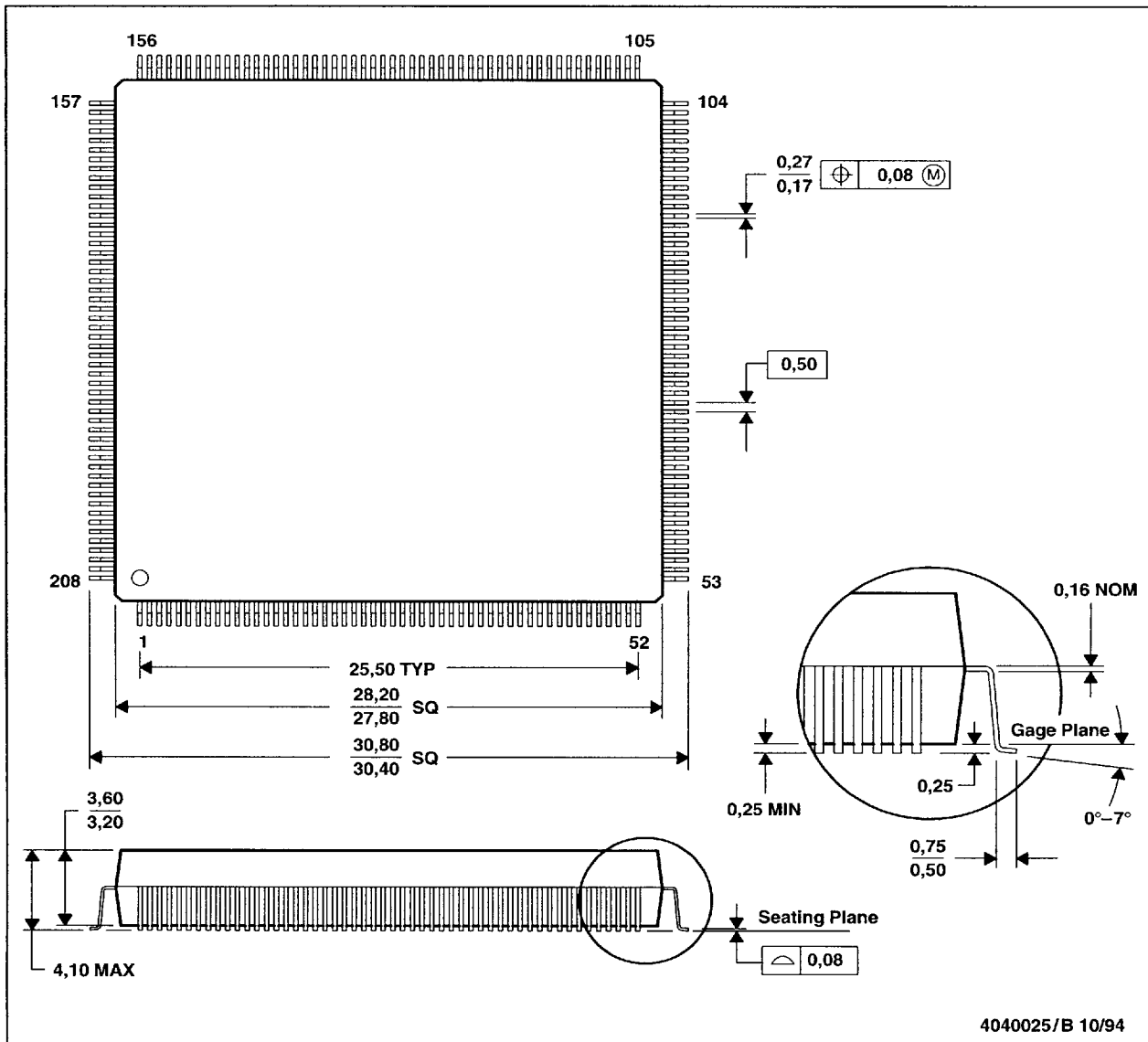
**TMS320C30
DIGITAL SIGNAL PROCESSOR**

SPRS032A -- APRIL 1996 -- REVISED JUNE 1997

MECHANICAL DATA

PPM (S-PQFP-G208)

PLASTIC QUAD FLATPACK



- NOTES: A. All linear dimensions are in millimeters.
 B. This drawing is subject to change without notice.
 C. Falls within JEDEC MO-143

Table 2. Thermal Resistance Characteristics for TMS320C30 PPM (PQFP Package)

PARAMETER	MAX	UNIT
$R_{\theta JA}$ Junction-to-free air	35.2	°C/W
$R_{\theta JC}$ Junction-to-case	8.5	°C/W

